

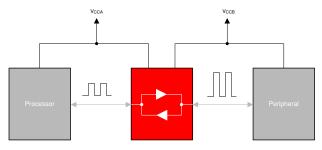
## TXB0104 4-Bit Bidirectional Voltage-Level Translator With Automatic Direction Sensing and ±15kV ESD Protection

## **1** Features

- 1.2V to 3.6V on A port and 1.65V to 5.5V on B port ( $V_{CCA} \le V_{CCB}$ )
- $V_{CC}$  isolation feature: if either  $V_{CC}$  input ss at GND, all outputs are in the high-impedance state
- Output enable (OE) input circuit referenced to V<sub>CCA</sub>
- Low power consumption, 5µA maximum I<sub>CC</sub>
- I OFF supports partial power-down mode operation
- Latch-up Performance Exceeds 100mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
  - A Port:
    - 2500V Human-Body Model (A114-B)
    - 1500V Charged-Device Model (C101)
  - B Port:
    - ±15kV Human-Body Model (A114-B)
    - 1500V Charged-Device Model (C101)

## 2 Applications

- Headsets
- Smartphones
- Tablets
- Desktop PC



**Typical Application Block Diagram for TXB010X** 

## **3 Description**

This TXB0104 4-bit noninverting translator uses two separate configurable power-supply rails. The A port is designed to track  $V_{CCA}$ .  $V_{CCA}$  accepts any supply voltage from 1.2V to 3.6V. The B port is designed to track  $V_{CCB}$ .  $V_{CCB}$  accepts any supply voltage from 1.65V to 5.5V. This allows for universal low-voltage bidirectional translation between any of the 1.2V, 1.5V, 1.8V, 2.5V, 3.3V, and 5V voltage nodes.  $V_{CCA}$  must not exceed  $V_{CCB}$ .

When the OE input is low, all outputs are placed in the high-impedance state. To ensure the high-impedance state during power up or power down, OE must be tied to GND through a pulldown resistor The current sourcing capability of the driver determines the minimum value of the resistor.

The TXB0104 device is designed so the OE input circuit is supplied by  $V_{\text{CCA}}.$ 

This device is fully specified for partial powerdown applications using I  $_{OFF}$ . The I  $_{OFF}$  circuitry disables the outputs, which prevents damaging current backflow through the device when the device is powered down.

| PART NUMBER (1) PACKAGE BODY SIZE (NOM) |   |  |  |  |  |  |  |  |
|---|---|--|--|--|--|--|--|--|
| PACKAGE                                 | BODY SIZE (NOM)   |  |  |  |  |  |  |  |
| UQFN (12)                               | 2.00mm × 1.70mm   |  |  |  |  |  |  |  |
| SOIC (14)                               | 8.65mm × 3.91mm   |  |  |  |  |  |  |  |
| BGA MICROSTAR<br>JUNIOR™ (12)           | 2.00mm × 2.50mm   |  |  |  |  |  |  |  |
| TSSOP (14)                              | 5.00mm × 4.40mm   |  |  |  |  |  |  |  |
| VQFN (14)                               | 3.50mm × 3.50mm   |  |  |  |  |  |  |  |
| DSBGA (12)                              | 1.40mm × 1.90mm   |  |  |  |  |  |  |  |
| NFBGA (12)                              | 2.00mm × 2.50mm   |  |  |  |  |  |  |  |
| WQFN (14)                               | 3.00mm × 2.50mm   |  |  |  |  |  |  |  |
| SOT (14)                                | 4.20mm × 2.00mm   |  |  |  |  |  |  |  |
|   | PACKAGE           UQFN (12)           SOIC (14)           BGA MICROSTAR           JUNIOR™ (12)           TSSOP (14)           VQFN (14)           DSBGA (12)           NFBGA (12)           WQFN (14) |  |  |  |  |  |  |  |

#### Package Information

(1) For all available packages, see the orderable addendum at the end of the data sheet.



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| (Other Packages)  |
| (   |

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## **4** Pin Configuration and Functions

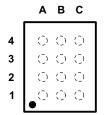
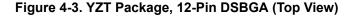


Figure 4-1. GXU and ZXU Package, 12-Pin BGA Microstar Junior (Top View)

|                  | 321 |  |
|------------------|-----|--|
| D<br>C<br>B<br>A |     |  |



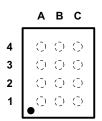
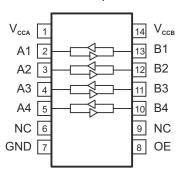
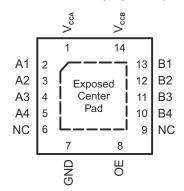


Figure 4-2. NMN Package, 12-Pin NFBGA (Top View)



NC - No internal connection

Figure 4-4. D/PW/DYY Package, 14-Pin SOIC/ TSSOP/SOT (Top View)





Exposed Thermal Pad (Top View)

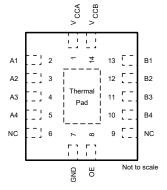
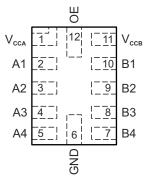


Figure 4-5. BQA Package, 14-Pin WQFN With Exposed Thermal Pad (Top View)





## Figure 4-7. RUT Package, 12-Pin UQFN (Top View)

#### Table 4-1. Pin Functions

|                  |       | P           | PIN |                     |     |     |  |
|------------------|-------|-------------|-----|---------------------|-----|-----|--|
| NAME             | D, PW | BQA,<br>RGY | RUT | GXU,<br>ZXU,<br>NMN | YZT | I/O | DESCRIPTION  |
| A1               | 2     | 2           | 2   | A1                  | A3  | I/O | Input/output 1. Referenced to V <sub>CCA</sub> .   |
| A2               | 3     | 3           | 3   | A2                  | B3  | I/O | Input/output 2. Referenced to V <sub>CCA</sub> .   |
| A3               | 4     | 4           | 4   | A3                  | C3  | I/O | Input/output 3. Referenced to V <sub>CCA</sub> .   |
| A4               | 5     | 5           | 5   | A4                  | D3  | I/O | Input/output 4. Referenced to V <sub>CCA</sub> .   |
| B1               | 13    | 13          | 10  | C1                  | A1  | I/O | Input/output 1. Referenced to V <sub>CCB</sub> .   |
| B2               | 12    | 12          | 9   | C2                  | B1  | I/O | Input/output 2. Referenced to V <sub>CCB</sub> .   |
| B3               | 11    | 11          | 8   | C3                  | C1  | I/O | Input/output 3. Referenced to V <sub>CCB</sub> .   |
| B4               | 10    | 10          | 7   | C4                  | D1  | I/O | Input/output 4. Referenced to V <sub>CCB</sub> .   |
| GND              | 7     | 7           | 6   | B4                  | D2  | —   | Ground   |
| NC               | 6, 9  | 6,9         | _   | _                   | _   |     | No connection. Not internally connected.   |
| OE               | 8     | 8           | 12  | B3                  | C2  | I   | Tri-state output-mode enable. Pull OE low to place all outputs in tri-state mode. Referenced to $V_{\text{CCA}}.$      |
| V <sub>CCA</sub> | 1     | 1           | 1   | B2                  | B2  |     | A-port supply voltage $1.2V \le V_{CCA} \le 3.6V$ and $V_{CCA} \le V_{CCB}$ .  |
| V <sub>CCB</sub> | 14    | 14          | 11  | B1                  | A2  | -   | B-port supply voltage $1.65V \le V_{CCB} \le 5.5V$ .   |
| Thermal<br>pad   | _     |             | _   |                     | _   | _   | For the BQA, RGY package, the exposed center thermal pad must either be connected to Ground or left electrically open. |

#### Table 4-2. Pin Assignments: NMN, GXU and ZXU Package

|   |    | ,                | 0  |
|---|----|------------------|----|
|   | А  | В                | С  |
| 4 | A4 | GND              | B4 |
| 3 | A3 | OE               | B3 |
| 2 | A2 | V <sub>CCA</sub> | B2 |
| 1 | A1 | V <sub>CCB</sub> | B1 |

#### Table 4-3. Pin Assignments: YZT Package

|   | 3  | 2                | 1  |
|---|----|------------------|----|
| D | A4 | GND              | B4 |
| C | A3 | OE               | B3 |
| В | A2 | V <sub>CCA</sub> | B2 |
| A | A1 | V <sub>CCB</sub> | B1 |



## **5** Specifications

### 5.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) <sup>(1)</sup>

|  |                    | MIN  | MAX                    | UNIT |
|--|--------------------|------|------------------------|------|
| Supply voltage, V <sub>CCA</sub>   | -0.5               | 4.6  | v                      |      |
| Supply voltage, V <sub>CCB</sub>   | -0.5               | 6.5  | v                      |      |
| Input voltage, V <sub>1</sub>  | A port             | -0.5 | 4.6                    | v    |
| ישני יטונפשט, יין  | B port             | -0.5 | 6.5                    | v    |
| Voltage applied to any output in the high-impedance or power-off             | A port             | -0.5 | 4.6                    | v    |
| state, V <sub>O</sub>  | B port             | -0.5 | 6.5                    | v    |
| Voltage applied to any output in the high or low state, V $_{ m O}$ $^{(2)}$ | A port             | -0.5 | V <sub>CCA</sub> + 0.5 | v    |
|  | B port             | -0.5 | V <sub>CCB</sub> + 0.5 | v    |
| Input clamp current, I <sub>IK</sub>   | V <sub>I</sub> < 0 |      | -50                    | mA   |
| Output clamp current, I <sub>OK</sub>  | V <sub>O</sub> < 0 |      | -50                    | mA   |
| Continuous output current, I <sub>O</sub>                                    |                    | -50  | 50                     | mA   |
| Continuous current through $V_{CCA}$ , $V_{CCB}$ , or GND                    | -100               | 100  | mA                     |      |
| Junction temperature range, T <sub>J</sub>                                   |                    | 150  | °C                     |      |
| Storage temperature range, T <sub>stg</sub>                                  |                    | -65  | 150                    | °C   |

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under Section 5.3 is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The value of V<sub>CCA</sub> and V<sub>CCB</sub> are provided in the recommended operating conditions table.

#### 5.2 ESD Ratings

|                    |   |  |        | VALUE | UNIT |  |
|--------------------|---|--|--------|-------|------|--|
| . Electrostatic    | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup> | A port   | ±2.5   |       | 1    |  |
|                    | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup> | B port   | ±15    | kV    |      |  |
| V <sub>(ESD)</sub> | discharge   | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | A port | ±1.5  | κv   |  |
|                    |   | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | B port | ±1.5  |      |  |

(1) JEDEC document JEP155 states that 500V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250V CDM allows safe manufacturing with a standard ESD control process.

## 5.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)<sup>(1) (2)</sup>

|   |   |   |   |                                   | MIN                                    | MAX                     | UNIT |
|---|---|---|---|-----------------------------------|--|-------------------------|------|
| $V_{CCA}$                               | Supply voltage                                      |   |   |                                   | 1.2                                    | 3.6                     | V    |
| $V_{CCB}$                               | Supply voltage                                      |   |   | 1.65                              | 5.5                                    | v                       |      |
| V                                       | High-level input voltage                            | Data<br>inputs  | V <sub>CCA</sub> = 1.2 V to 3.6 V<br>V <sub>CCB</sub> = 1.65 V to 5.5 V |                                   | V <sub>CCI</sub> × 0.65 <sup>(3)</sup> | V <sub>CCI</sub>        | V    |
| V <sub>IH</sub>                         | nigh-level input voltage                            | OE  | V <sub>CCA</sub> = 1.2 V to 3.6 V<br>V <sub>CCB</sub> = 1.65 V to 5.5 V |                                   | V <sub>CCA</sub> × 0.65                | 5.5                     | v    |
| V <sub>IL</sub> Low-level input voltage | Data<br>inputs                                      | V <sub>CCA</sub> = 1.2 V to 5.5 V<br>V <sub>CCB</sub> = 1.65 V to 5.5 V |   | 0                                 | V <sub>CCI</sub> × 0.35 <sup>(3)</sup> | V                       |      |
|   | Low-level input voitage                             | OE  | V <sub>CCA</sub> = 1.2 V to 3.6 V<br>V <sub>CCB</sub> = 1.65 V to 5.5 V |                                   | 0                                      | V <sub>CCA</sub> × 0.35 | v    |
| Vo                                      | Voltage applied to any output in the high-impedance | A-port  | $V_{CCA}$ = 1.2 V to 3.6 V<br>V <sub>CCB</sub> = 1.65 V to 5.5 V        |                                   | 0                                      | 3.6                     | V    |
| ۷Ö                                      | or power-off state                                  | B-port  | $V_{CCA}$ = 1.2 V to 3.6 V<br>V <sub>CCB</sub> = 1.65 V to 5.5 V        |                                   | 0                                      | 5.5                     | v    |
| Input transition                        | A-port<br>inputs                                    | V <sub>CCA</sub> = 1.2 V to 3.6 V<br>V <sub>CCB</sub> = 1.65 V to 5.5 V |   |                                   | 40                                     |                         |      |
| Δt/Δv                                   | rise or fall rate                                   | B-port  | V <sub>CCA</sub> = 1.2 V to 3.6 V                                       | $V_{CCB}$ = 1.65 V to 3.6 V       |  | 40                      | ns/V |
|   |   | inputs  | VCCA - 1.2 V 10 3.0 V   | V <sub>CCB</sub> = 4.5 V to 5.5 V |  | 30                      |      |
| T <sub>A</sub>                          | Operating free-air temperature                      |   |   |                                   | -40                                    | 85                      | °C   |

The A and B sides of an unused data I/O pair must be held in the same state, that is, both at V<sub>CCI</sub> or both at GND.  $V_{CCA}$  must be less than or equal to V<sub>CCB</sub> and must not exceed 3.6 V.  $V_{CCI}$  is the supply voltage associated with the input port. (1)

(2)

(3)

### **5.4 Thermal Information**

|                           |   |         | TXB0104     |         |         |         |         |         |         |         |          |
|---------------------------|---|---------|-------------|---------|---------|---------|---------|---------|---------|---------|----------|
|                           | THERMAL METRIC <sup>(1)</sup>                   | D       | GXU/ZX<br>U | PW      | RGY     | RUT     | YZT     | NMN     | BQA     | DYY     | UNI<br>T |
|                           |   | 14 PINS | 12 PINS     | 14 PINS | 14 PINS | 12 PINS | 12 PINS | 12 PINS | 14 PINS | 14 PINS |          |
| R <sub>θJA</sub>          | Junction-to-ambient thermal resistance          | 90.7    | 127.1       | 121.0   | 52.8    | 119.8   | 89.2    | 134.3   | 77.1    | 165.0   |          |
| R <sub>θ</sub><br>JC(top) | Junction-to-case (top)<br>thermal resistance    | 50.5    | 92.8        | 50.0    | 67.7    | 42.6    | 0.9     | 90.7    | 80.7    | 87.5    |          |
| R <sub>θJB</sub>          | Junction-to-board thermal resistance            | 45.4    | 62.2        | 62.8    | 28.9    | 52.5    | 14.4    | 88.4    | 46.9    | 83.2    | °C/      |
| Ψ <sub>JT</sub>           | Junction-to-top<br>characterization parameter   | 14.7    | 2.3         | 6.4     | 2.6     | 0.7     | 3.0     | 4.3     | 6.1     | 9.3     | W        |
| Ψ <sub>JB</sub>           | Junction-to-board characterization parameter    | 45.1    | 62.2        | 62.2    | 29.0    | 52.3    | 14.4    | 89.3    | 46.8    | 83.1    |          |
| R <sub>θ</sub><br>JC(bot) | Junction-to-case (bottom)<br>thermal resistance | _       | —           | _       | _       | _       | _       | —       | 23.3    | -       |          |

(1) For more information about traditional and new thermal metrics, see the IC Package Thermal Metrics application report.



## 5.5 Electrical Characteristics (BQA/DYY)

over recommended operating free-air temperature range (unless otherwise noted)

|  | AMETER <sup>(1)</sup> (2)                              | TEST CONDITIONS  | V                | V                | T <sub>A</sub> | = 25°C |     | –40°C to 8             | 5°C | UNI  |
|--|--|--|------------------|------------------|----------------|--------|-----|------------------------|-----|------|
| PAR  |  | TEST CONDITIONS  | V <sub>CCA</sub> | V <sub>CCB</sub> | MIN            | TYP    | MAX | MIN                    | MAX | UNI  |
|  | Port A output  | L = 20 uA  | 1.2 V            |                  |                | 1.1    |     |                        |     | v    |
| V <sub>OHA</sub> high voltage  |  | I <sub>OH</sub> = –20 μA                                 | 1.4 V to 3.6 V   |                  |                |        |     | V <sub>CCA</sub> - 0.4 |     | v    |
| V  | Port A output  | I <sub>OL</sub> = 20 μA                                  | 1.2 V            |                  |                | 0.3    |     |                        |     | v    |
| V <sub>OLA</sub>   | low voltage  | ι <sub>OL</sub> – 20 μΑ                                  | 1.4 V to 3.6 V   |                  |                |        |     |                        | 0.4 | v    |
| V <sub>OHB</sub>   | Port B output<br>high voltage                          | I <sub>OH</sub> = –20 μA                                 |                  | 1.65 V to 5.5 V  |                |        |     | V <sub>CCB</sub> – 0.4 |     | V    |
| V <sub>OLB</sub>   | Port B output<br>low voltage                           | I <sub>OL</sub> = 20 μA                                  |                  | 1.65 V to 5.5 V  |                |        |     |                        | 0.4 | V    |
| I <sub>I</sub>   | Inflection-point current                               | OE:<br>V <sub>I</sub> = V <sub>CCI</sub> or GND          | 1.2 V to 3.6 V   | 1.65 V to 5.5 V  | -1             |        | 1   | -2                     | 2   | μA   |
| 1  | Off-state  | A port:<br>V <sub>I</sub> or V <sub>O</sub> = 0 to 3.6 V | 0 V              | 0 V to 5.5 V     | -1             |        | 1   | -2                     | 2   |      |
| I <sub>off</sub>   | current  | B port:<br>V <sub>I</sub> or V <sub>O</sub> = 0 to 5.5 V | 0 V to 3.6 V     | 0 V              | -1             |        | 1   | -2                     | 2   | μA   |
| I <sub>oz</sub>  | High-<br>impedance-<br>state output<br>current         | A or B port:<br>OE = GND                                 | 1.2 V to 3.6 V   | 1.65 V to 5.5 V  | -1             |        | 1   | -2                     | 2   | μA   |
|  |  |  | 1.2 V            | 1.65 V to 5.5 V  |                | 0.4    |     |                        |     | - uA |
| V <sub>CCA</sub> supply  | V <sub>CCA</sub> supply                                | $V_I = V_{CCI}$ or GND<br>$I_O = 0$                      | 1.4 V to 3.6 V   | 1.65 V to 5.5 V  |                |        |     |                        | 5   |      |
| I <sub>CCA</sub>   | current  |  | 3.6 V            | 0 V              |                |        |     |                        | 2.5 |      |
|  |  |  | 0 V              | 5.5 V            |                |        |     |                        | -2  |      |
|  |  |  | 1.2 V            | 1.65 V to 5.5 V  |                | 3.4    |     |                        |     |      |
|  | V <sub>CCB</sub> supply                                | $V_1 = V_{CC1}$ or GND<br>$I_0 = 0$                      | 1.4 V to 3.6 V   | 1.65 V to 5.5 V  |                |        |     |                        | 5   | μA   |
| ССВ  | current  |  | 3.6 V            | 0 V              |                |        |     |                        | -2  |      |
|  |  |  | 0 V              | 5.5 V            |                |        |     |                        | 2   |      |
| I <sub>CCA</sub> +   | Combined   | V <sub>I</sub> = V <sub>CCI</sub> or GND                 | 1.2 V            | 1.65 V to 5.5 V  |                | 3.5    |     |                        |     |      |
| ССВ  | supply current   | $I_{O} = 0$  | 1.4 V to 3.6 V   | 1.65 V to 5.5 V  |                |        |     |                        | 10  | μA   |
|  | High-  | V <sub>I</sub> = V <sub>CCI</sub> or GND                 | 1.2 V            | 1.65 V to 5.5 V  |                | 0.4    |     |                        |     |      |
| CCZA   | impedance<br>state, V <sub>CCA</sub><br>supply current | $I_0 = 0,$<br>OE = GND                                   | 1.4 V to 3.6 V   | 1.65 V to 5.5 V  |                |        |     |                        | 5   | μA   |
|  | High-  | $V_{\rm H} = V_{\rm cont}  {\rm or}  {\rm GND}$          | 1.2 V            | 1.65 V to 5.5 V  |                | 3.3    |     |                        |     |      |
| I <sub>CCZB</sub> impedance<br>state, V <sub>CCB</sub><br>supply current |  | $V_I = V_{CCI}$ or GND<br>$I_O = 0$ ,<br>OE = GND        | 1.4 V to 3.6 V   | 1.65 V to 5.5 V  |                |        |     |                        | 5   | μA   |
| C <sub>i</sub>   | Input<br>capacitance                                   | OE   | 1.2 V to 3.6 V   | 1.65 V to 5.5 V  |                | 3      |     |                        | 6.5 | pF   |
| _  |  | A port   | 1.2 V to 3.6 V   | 1.65 V to 5.5 V  |                | 5      |     |                        | 6   |      |
| C <sub>io</sub>  | internal<br>capacitance                                | B port   | 1.2 V to 3.6 V   | 1.65 V to 5.5 V  |                | 11     |     |                        | 14  | pF   |



## 5.6 Electrical Characteristics (Other Packages)

over recommended operating free-air temperature range (unless otherwise noted)

|                    | AMETER <sup>(1)</sup> (2)                              | TEST CONDITIONS  | Varia            | Vere             | TA  | = 25°C |     | –40°C to 8             | 5°C |          |
|--------------------|--|--|------------------|------------------|-----|--------|-----|------------------------|-----|----------|
| PAR                |  | TEST CONDITIONS  | V <sub>CCA</sub> | V <sub>CCB</sub> | MIN | TYP    | MAX | MIN                    | MAX | UNI      |
|                    | Port A output  | L = 20 µA  | 1.2 V            |                  |     | 1.1    |     |                        |     | v        |
| V <sub>OHA</sub>   | high voltage   | I <sub>OH</sub> = –20 μA                                 | 1.4 V to 3.6 V   |                  |     |        |     | $V_{CCA} - 0.4$        |     |          |
| <b>.</b>           | Port A output  | L = 20 uA  | 1.2 V            |                  |     | 0.3    |     |                        |     | v        |
| V <sub>OLA</sub>   | low voltage  | I <sub>OL</sub> = 20 μΑ                                  | 1.4 V to 3.6 V   |                  |     |        |     |                        | 0.4 | v        |
| V <sub>OHB</sub>   | Port B output<br>high voltage                          | I <sub>OH</sub> = –20 μA                                 |                  | 1.65 V to 5.5 V  |     |        |     | V <sub>CCB</sub> – 0.4 |     | v        |
| V <sub>OLB</sub>   | Port B output<br>low voltage                           | I <sub>OL</sub> = 20 μA                                  |                  | 1.65 V to 5.5 V  |     |        |     |                        | 0.4 | V        |
| I <sub>I</sub>     | Inflection-point current                               | OE:<br>V <sub>I</sub> = V <sub>CCI</sub> or GND          | 1.2 V to 3.6 V   | 1.65 V to 5.5 V  | -1  |        | 1   | -2                     | 2   | μA       |
| 1 ~                | Off-state  | A port:<br>V <sub>I</sub> or V <sub>O</sub> = 0 to 3.6 V | 0 V              | 0 V to 5.5 V     | -1  |        | 1   | -2                     | 2   | μA       |
| I <sub>off</sub>   | current  | B port:<br>V <sub>I</sub> or V <sub>O</sub> = 0 to 5.5 V | 0 V to 3.6 V     | 0 V              | -1  |        | 1   | -2                     | 2   | μΑ       |
| l <sub>oz</sub>    | High-<br>impedance-<br>state output<br>current         | A or B port:<br>OE = GND                                 | 1.2 V to 3.6 V   | 1.65 V to 5.5 V  | -1  |        | 1   | -2                     | 2   | μA       |
|                    |  |  | 1.2 V            | 1.65 V to 5.5 V  |     | 0.06   |     |                        |     |          |
|                    |  | V <sub>I</sub> = V <sub>CCI</sub> or GND                 | 1.4 V to 3.6 V   | 1.65 V to 5.5 V  |     |        |     |                        | 5   | μA       |
| I <sub>CCA</sub>   |  | I <sub>O</sub> = 0                                       | 3.6 V            | 0 V              |     |        |     |                        | 2   | μ        |
|                    |  |  | 0 V              | 5.5 V            |     |        |     |                        | -2  |          |
|                    |  |  | 1.2 V            | 1.65 V to 5.5 V  |     | 3.4    |     |                        |     |          |
|                    | V <sub>CCB</sub> supply                                | V <sub>I</sub> = V <sub>CCI</sub> or GND                 | 1.4 V to 3.6 V   | 1.65 V to 5.5 V  |     |        |     |                        | 5   | <i>.</i> |
| I <sub>CCB</sub>   | current  | I <sub>O</sub> = 0                                       | 3.6 V            | 0 V              |     |        |     |                        | -2  | μA       |
|                    |  |  | 0 V              | 5.5 V            |     |        |     |                        | 2   |          |
| I <sub>CCA</sub> + | Combined   | V <sub>I</sub> = V <sub>CCI</sub> or GND                 | 1.2 V            | 1.65 V to 5.5 V  |     | 3.5    |     |                        |     |          |
| ССВ                | supply current   | $I_{O} = 0$  | 1.4 V to 3.6 V   | 1.65 V to 5.5 V  |     |        |     |                        | 10  | μA       |
|                    | High-  | V <sub>I</sub> = V <sub>CCI</sub> or GND                 | 1.2 V            | 1.65 V to 5.5 V  |     | 0.05   |     |                        |     |          |
| I <sub>CCZA</sub>  | impedance<br>state, V <sub>CCA</sub><br>supply current | $I_0 = 0,$<br>OE = GND                                   | 1.4 V to 3.6 V   | 1.65 V to 5.5 V  |     |        |     |                        | 5   | μA       |
|                    | High-  | V <sub>I</sub> = V <sub>CCI</sub> or GND                 | 1.2 V            | 1.65 V to 5.5 V  |     | 3.3    |     |                        |     |          |
| ссzв               | impedance<br>state, V <sub>CCB</sub><br>supply current | $V_1 = V_{CCI}$ of GND<br>$I_0 = 0,$<br>OE = GND         | 1.4 V to 3.6 V   | 1.65 V to 5.5 V  |     |        |     |                        | 5   | μA       |
| C <sub>i</sub>     | Input<br>capacitance                                   | OE   | 1.2 V to 3.6 V   | 1.65 V to 5.5 V  |     | 3      |     |                        | 4   | pF       |
|                    | Input-to-output  | A port   | 1.2 V to 3.6 V   | 1.65 V to 5.5 V  |     | 5      |     |                        | 6   |          |
| Cio                | internal capacitance                                   | B port   | 1.2 V to 3.6 V   | 1.65 V to 5.5 V  |     | 11     |     |                        | 14  | pF       |



### 5.7 Timing Requirements: V<sub>CCA</sub> = 1.2 V

T<sub>A</sub> = 25°C, V<sub>CCA</sub> = 1.2 V

|    |                |             | ٧c  | <sub>CB</sub> = 1.8 | V   | Vc  | <sub>св</sub> = 2.8 | 5 V | Vc  | <sub>св</sub> = 3. | 3 V | Va  | ссв = 5 | V    | UNIT |
|----|----------------|-------------|-----|---------------------|-----|-----|---------------------|-----|-----|--------------------|-----|-----|---------|------|------|
|    |                |             | MIN | TYP                 | MAX | MIN | TYP                 | MAX | MIN | TYP                | MAX | MIN | TYP     | MAX  | UNIT |
|    | Data rate      |             | 20  |                     |     | 20  |                     |     | 20  |                    |     | 20  |         | Mbps |      |
| tw | Pulse duration | Data inputs |     | 50                  |     |     | 50                  |     |     | 50                 |     |     | 50      |      | ns   |

## 5.8 Timing Requirements: V<sub>CCA</sub> = 1.5 V $\pm$ 0.1 V

over recommended operating free-air temperature range, V<sub>CCA</sub> = 1.5 V ± 0.1 V (unless otherwise noted)

|    |                |             | V <sub>CCB</sub> = 1.8 V<br>± 0.15 V |     |     | = 2.5 V<br>.2 V |     | = 3.3 V<br>).3 V | V <sub>ССВ</sub><br>± 0. | = 5 V<br>.5 V | UNIT |
|----|----------------|-------------|--------------------------------------|-----|-----|-----------------|-----|------------------|--------------------------|---------------|------|
|    |                |             | MIN                                  | MAX | MIN | MAX             | MIN | MAX              | MIN                      | MAX           |      |
|    | Data rate      |             |                                      | 40  |     | 40              |     | 40               |                          | 40            | Mbps |
| tw | Pulse duration | Data inputs | 25                                   |     | 25  |                 | 25  |                  | 25                       |               | ns   |

### 5.9 Timing Requirements: $V_{CCA}$ = 1.8 V ± 0.15 V

over recommended operating free-air temperature range, V<sub>CCA</sub> = 1.8 V ± 0.15 V (unless otherwise noted)

|    |                |             | V <sub>ссв</sub> :<br>± 0. | = 1.8 V<br>15 V |     | = 2.5 V<br>.2 V | V <sub>ССВ</sub> :<br>± 0 | = 3.3 V<br>.3 V | V <sub>ССВ</sub><br>± 0 | = 5 V<br>.5 V | UNIT |
|----|----------------|-------------|----------------------------|-----------------|-----|-----------------|---------------------------|-----------------|-------------------------|---------------|------|
|    |                |             | MIN                        | MAX             | MIN | MAX             | MIN                       | MAX             | MIN                     | MAX           |      |
|    | Data rate      |             |                            | 60              |     | 60              |                           | 60              |                         | 60            | Mbps |
| tw | Pulse duration | Data inputs | 17                         |                 | 17  |                 | 17                        |                 | 17                      |               | ns   |

### 5.10 Timing Requirements: $V_{CCA} = 2.5 V \pm 0.2 V$

over recommended operating free-air temperature range, V<sub>CCA</sub> = 2.5 V ± 0.2 V (unless otherwise noted)

|                |                |             | V <sub>CCB</sub> =<br>± 0. |     |     | = 3.3 V<br>.3 V | V <sub>CCE</sub><br>± 0 | s = 5 V<br>.5 V | UNIT |
|----------------|----------------|-------------|----------------------------|-----|-----|-----------------|-------------------------|-----------------|------|
|                |                |             | MIN                        | MAX | MIN | MAX             | MIN                     | MAX             |      |
|                | Data rate      |             |                            | 100 |     | 100             |                         | 100             | Mbps |
| t <sub>w</sub> | Pulse duration | Data inputs | 10                         |     | 10  |                 | 10                      |                 | ns   |

### 5.11 Timing Requirements: $V_{CCA}$ = 3.3 V ± 0.3 V

over recommended operating free-air temperature range,  $V_{CCA}$  = 3.3 V ± 0.3 V (unless otherwise noted)

|                |                |             |     | = 3.3 V<br>0.3 V | V <sub>CCB</sub><br>± 0 | = 5 V<br>.5 V | UNIT |
|----------------|----------------|-------------|-----|------------------|-------------------------|---------------|------|
|                |                |             | MIN | MAX              | MIN                     | MAX           |      |
|                | Data rate      |             |     | 100              |                         | 100           | Mbps |
| t <sub>w</sub> | Pulse duration | Data inputs | 10  |                  | 10                      |               | ns   |

## 5.12 Switching Characteristics: V<sub>CCA</sub> = 1.2 V (BQA/DYY)

 $T_A = 25^{\circ}C, V_{CCA} = 1.2 V$ 

|                                   | RAMETER                                | TEST                          | V <sub>CCB</sub> = 1 | .8 V   | V <sub>CCB</sub> = 2.8 | v     | V <sub>CCB</sub> = 3.3 | V   | V <sub>CCE</sub> | ; = 5 V |     | UNIT |
|-----------------------------------|--|-------------------------------|----------------------|--------|------------------------|-------|------------------------|-----|------------------|---------|-----|------|
|                                   |  | CONDITIONS                    | MIN T                | ҮР МАХ | MIN TY                 | P MAX | MIN TYP                | MAX | MIN              | TYP     | MAX | UNIT |
|                                   | Propagation                            | A-to-B                        | 6                    | 3.9    | 5.                     | 7     | 5.3                    |     |                  | 5.5     |     | ns   |
| t <sub>pd</sub>                   | delay time                             | B-to-A                        | 7                    | 7.4    | 6.                     | 1     | 6                      |     |                  | 5.8     |     | 115  |
|                                   | Enable time                            | OE-to-A                       |                      | 1      |                        | 1     | 1                      |     |                  | 1       |     |      |
| t <sub>en</sub>                   |  | OE-to-B                       |                      | 1      |                        | 1     | 1                      |     |                  | 1       |     | μs   |
| t.e.                              | t <sub>dis</sub> Disable time          | OE-to-A                       | 3                    | 92     | 39                     | 2     | 392                    |     |                  | 392     |     | ns   |
| -ais                              |  | OE-to-B                       | 3                    | 92     | 39                     | 2     | 392                    |     |                  | 392     |     | 115  |
| t <sub>rA</sub> , t <sub>fA</sub> | Input rise<br>time, input<br>fall time | A-port rise<br>and fall times | 2                    | 1.2    | 4.                     | 2     | 4.2                    |     |                  | 4.2     |     | ns   |
| t <sub>rB</sub> , t <sub>fB</sub> | Input rise<br>time, input<br>fall time | B-port rise<br>and fall times | 2                    | 2.1    | 1.                     | 5     | 1.2                    |     |                  | 1.1     |     | ns   |
| t <sub>SK(O)</sub>                | Skew (time),<br>output                 | Channel-to-<br>channel skew   | (                    | ).4    | 0.                     | 5     | 0.5                    |     |                  | 1.4     |     | ns   |
|                                   | Maximum<br>data rate                   |                               | 20                   |        | 2                      | )     | 20                     |     |                  | 20      |     | Mbps |

## 5.13 Switching Characteristics: V<sub>CCA</sub> = 1.2 V (Other Packages)

T<sub>A</sub> = 25°C, V<sub>CCA</sub> = 1.2 V

| БА                                | RAMETER                                | TEST                          | Vcc | <sub>B</sub> = 1.8 \ | /   | Vcc | <sub>B</sub> = 2.5 V |     | Vcc | <sub>B</sub> = 3.3 V | '   | Vc  | <sub>CB</sub> = 5 V |     | UNIT |
|-----------------------------------|--|-------------------------------|-----|----------------------|-----|-----|----------------------|-----|-----|----------------------|-----|-----|---------------------|-----|------|
| PA                                | RAIVIETER                              | CONDITIONS                    | MIN | TYP                  | MAX | MIN | TYP                  | MAX | MIN | TYP                  | MAX | MIN | TYP                 | MAX | UNIT |
| +                                 | Propagation                            | A-to-B                        |     | 6.9                  |     |     | 5.7                  |     |     | 5.3                  |     |     | 5.5                 |     | ns   |
| t <sub>pd</sub>                   | delay time                             | B-to-A                        |     | 7.4                  |     |     | 6.4                  |     |     | 6                    |     |     | 5.8                 |     | 115  |
| +                                 | Enable time                            | OE-to-A                       |     | 1                    |     |     | 1                    |     |     | 1                    |     |     | 1                   |     |      |
| t <sub>en</sub>                   |  | OE-to-B                       |     | 1                    |     |     | 1                    |     |     | 1                    |     |     | 1                   |     | μs   |
| t <sub>dis</sub> I                | Disable time                           | OE-to-A                       |     | 18                   |     |     | 15                   |     |     | 14                   |     |     | 14                  |     | ns   |
| <sup>L</sup> dis                  |  | OE-to-B                       |     | 20                   |     |     | 17                   |     |     | 16                   |     |     | 16                  |     | 115  |
| t <sub>rA</sub> , t <sub>fA</sub> | Input rise<br>time, input<br>fall time | A-port rise<br>and fall times |     | 4.2                  |     |     | 4.2                  |     |     | 4.2                  |     |     | 4.2                 |     | ns   |
| t <sub>rB</sub> , t <sub>fB</sub> | Input rise<br>time, input<br>fall time | B-port rise<br>and fall times |     | 2.1                  |     |     | 1.5                  |     |     | 1.2                  |     |     | 1.1                 |     | ns   |
| t <sub>SK(O)</sub>                | Skew (time),<br>output                 | Channel-to-<br>channel skew   |     | 0.4                  |     |     | 0.5                  |     |     | 0.5                  |     |     | 1.4                 |     | ns   |
|                                   | Maximum<br>data rate                   |                               |     | 20                   |     |     | 20                   |     |     | 20                   |     |     | 20                  |     | Mbps |



## 5.14 Switching Characteristics: $V_{CCA}$ = 1.5 V $\pm$ 0.1 V (BQA/DYY)

over recommended operating free-air temperature range,  $V_{CCA}$  = 1.5 V ± 0.1 V (unless otherwise noted)

| PA                                | PARAMETER                              | TEST<br>CONDITIONS               | V <sub>CCB</sub> =<br>± 0.1 | = 1.8 V<br>15 V |     | = 2.5 V<br>0.2 V |     | = 3.3 V<br>.3 V |     | = 5 V<br>.5 V | UNIT |
|-----------------------------------|--|----------------------------------|-----------------------------|-----------------|-----|------------------|-----|-----------------|-----|---------------|------|
|                                   |  | CONDITIONS                       | MIN                         | MAX             | MIN | MAX              | MIN | MAX             | MIN | MAX           | ]    |
| +                                 | Propagation                            | A-to-B                           | 1.4                         | 12.9            | 1.2 | 10.1             | 1.1 | 10              | 0.8 | 9.9           | - ns |
| t <sub>pd</sub>                   | delay time                             | B-to-A                           | 0.9                         | 14.2            | 0.7 | 12               | 0.4 | 11.7            | 0.3 | 13.7          | 115  |
|                                   | Enable time                            | OE-to-A                          |                             | 1               |     | 1                |     | 1               |     | 1             |      |
| t <sub>en</sub>                   |  | OE-to-B                          |                             | 1               |     | 1                |     | 1               |     | 1             | μs   |
|                                   |  | OE-to-A                          | 278                         | 390             | 236 | 305              | 236 | 305             | 236 | 305           |      |
| t <sub>dis</sub>                  | Disable time                           | OE-to-B                          | 278                         | 390             | 236 | 305              | 236 | 305             | 236 | 305           | ns   |
| t <sub>rA</sub> , t <sub>fA</sub> | Input rise<br>time, input<br>fall time | A-port<br>rise and<br>fall times | 1.4                         | 5.1             | 1.4 | 5.1              | 1.4 | 5.1             | 1.4 | 5.1           | ns   |
| t <sub>rB</sub> , t <sub>fB</sub> | Input rise<br>time, input<br>fall time | B-port<br>rise and<br>fall times | 0.9                         | 4.5             | 0.6 | 3.2              | 0.5 | 2.8             | 0.4 | 2.7           | ns   |
| t <sub>SK(O)</sub>                | Skew (time),<br>output                 | Channel-to-<br>channel skew      |                             | 0.5             |     | 0.5              |     | 0.5             |     | 0.5           | ns   |
|                                   | Maximum<br>data rate                   |                                  | 40                          |                 | 40  |                  | 40  |                 | 40  |               | Mbps |

## 5.15 Switching Characteristics: $V_{CCA}$ = 1.5 V ± 0.1 V (Other Packages)

over recommended operating free-air temperature range,  $V_{CCA}$  = 1.5 V ± 0.1 V (unless otherwise noted)

| PA                                | PARAMETER                              | TEST                             |     | = 1.8 V<br>15 V |     | = 2.5 V<br>.2 V |     | = 3.3 V<br>.3 V |     | = 5 V<br>.5 V | UNIT |
|-----------------------------------|--|----------------------------------|-----|-----------------|-----|-----------------|-----|-----------------|-----|---------------|------|
|                                   |  | CONDITIONS                       | MIN | MAX             | MIN | MAX             | MIN | MAX             | MIN | MAX           |      |
|                                   | Propagation                            | A-to-B                           | 1.4 | 12.9            | 1.2 | 10.1            | 1.1 | 10              | 0.8 | 9.9           |      |
| t <sub>pd</sub>                   | delay time                             | B-to-A                           | 0.9 | 14.2            | 0.7 | 12              | 0.4 | 11.7            | 0.3 | 13.7          | ns   |
|                                   | Enable time                            | OE-to-A                          |     | 1               |     | 1               |     | 1               |     | 1             |      |
| t <sub>en</sub>                   | Enable time                            | OE-to-B                          |     | 1               |     | 1               |     | 1               |     | 1             | μs   |
|                                   | Disable time                           | OE-to-A                          | 5.9 | 31              | 5.7 | 25.9            | 5.6 | 23              | 5.7 | 22.4          |      |
| t <sub>dis</sub>                  |  | OE-to-B                          | 5.4 | 30.3            | 4.9 | 22.8            | 4.8 | 20              | 4.9 | 19.5          | ns   |
| t <sub>rA</sub> , t <sub>fA</sub> | Input rise<br>time, input<br>fall time | A-port<br>rise and<br>fall times | 1.4 | 5.1             | 1.4 | 5.1             | 1.4 | 5.1             | 1.4 | 5.1           | ns   |
| t <sub>rB</sub> , t <sub>fB</sub> | Input rise<br>time, input<br>fall time | B-port<br>rise and<br>fall times | 0.9 | 4.5             | 0.6 | 3.2             | 0.5 | 2.8             | 0.4 | 2.7           | ns   |
| t <sub>SK(O)</sub>                | Skew (time),<br>output                 | Channel-to-<br>channel skew      |     | 0.5             |     | 0.5             |     | 0.5             |     | 0.5           | ns   |
|                                   | Maximum<br>data rate                   |                                  | 40  |                 | 40  |                 | 40  |                 | 40  |               | Mbp  |



## 5.16 Switching Characteristics: V<sub>CCA</sub> = 1.8 V ± 0.15 V (BQA/DYY)

over recommended operating free-air temperature range,  $V_{CCA} = 1.8 \text{ V} \pm 0.15 \text{ V}$  (unless otherwise noted)

| PAF                               | PARAMETER                              | TEST<br>CONDITIONS               |     | = 1.8 V<br>15 V |     | = 2.5 V<br>.2 V |     | = 3.3 V<br>.3 V |     | = 5 V<br>.5 V | UNIT |
|-----------------------------------|--|----------------------------------|-----|-----------------|-----|-----------------|-----|-----------------|-----|---------------|------|
|                                   |  | CONDITIONS                       | MIN | MAX             | MIN | MAX             | MIN | MAX             | MIN | MAX           |      |
| +                                 | Propagation                            | A-to-B                           | 1.6 | 11              | 1.4 | 7.7             | 1.3 | 6.8             | 1.2 | 6.5           | ns   |
| t <sub>pd</sub>                   | delay time                             | B-to-A                           | 1.5 | 12              | 1.3 | 8.4             | 1   | 7.6             | 0.9 | 7.1           | 115  |
| +                                 | Enable time                            | OE-to-A                          |     | 1               |     | 1               |     | 1               |     | 1             |      |
| t <sub>en</sub>                   |  | OE-to-B                          |     | 1               |     | 1               |     | 1               |     | 1             | μs   |
|                                   | Disable                                | OE-to-A                          | 278 | 389             | 191 | 253             | 190 | 248             | 189 | 248           |      |
| t <sub>dis</sub>                  | time                                   | OE-to-B                          | 278 | 389             | 191 | 253             | 190 | 248             | 189 | 248           | ns   |
| t <sub>rA</sub> , t <sub>fA</sub> | Input rise<br>time, input<br>fall time | A-port<br>rise and<br>fall times | 1   | 4.2             | 1.1 | 4.1             | 1.1 | 4.1             | 1.1 | 4.1           | ns   |
| t <sub>rB</sub> , t <sub>fB</sub> | Input rise<br>time, input<br>fall time | B-port<br>rise and<br>fall times | 0.9 | 3.8             | 0.6 | 3.2             | 0.5 | 2.8             | 0.4 | 2.7           | ns   |
| t <sub>SK(O)</sub>                | Skew<br>(time),<br>output              | Channel-to-<br>channel skew      |     | 0.5             |     | 0.5             |     | 0.5             |     | 0.5           | ns   |
|                                   | Maximum<br>data rate                   |                                  | 60  |                 | 60  |                 | 60  |                 | 60  |               | Mbps |

### 5.17 Switching Characteristics: $V_{CCA}$ = 1.8 V ± 0.15 V (Other Packages)

over recommended operating free-air temperature range,  $V_{CCA}$  = 1.8 V ± 0.15 V (unless otherwise noted)

| PAF                               | PARAMETER                              | TEST<br>CONDITIONS               |     | = 1.8 V<br>15 V |     | = 2.5 V<br>.2 V |     | = 3.3 V<br>.3 V |     | = 5 V<br>.5 V | UNIT |
|-----------------------------------|--|----------------------------------|-----|-----------------|-----|-----------------|-----|-----------------|-----|---------------|------|
|                                   |  | CONDITIONS                       | MIN | MAX             | MIN | MAX             | MIN | MAX             | MIN | MAX           | ]    |
| +                                 | Propagation                            | A-to-B                           | 1.6 | 11              | 1.4 | 7.7             | 1.3 | 6.8             | 1.2 | 6.5           | ns   |
| t <sub>pd</sub>                   | delay time                             | B-to-A                           | 1.5 | 12              | 1.3 | 8.4             | 1   | 7.6             | 0.9 | 7.1           | 115  |
|                                   | Enable time                            | OE-to-A                          |     | 1               |     | 1               |     | 1               |     | 1             |      |
| t <sub>en</sub>                   | Enable lime                            | OE-to-B                          |     | 1               |     | 1               |     | 1               |     | 1             | μs   |
|                                   | <sup>dis</sup> time (                  | OE-to-A                          | 5.9 | 31              | 5.1 | 21.3            | 5   | 19.3            | 5   | 17.4          |      |
| t <sub>dis</sub>                  |  | OE-to-B                          | 5.4 | 30.3            | 4.4 | 20.8            | 4.2 | 17.9            | 4.3 | 16.3          | ns   |
| t <sub>rA</sub> , t <sub>fA</sub> | Input rise<br>time, input<br>fall time | A-port<br>rise and<br>fall times | 1   | 4.2             | 1.1 | 4.1             | 1.1 | 4.1             | 1.1 | 4.1           | ns   |
| t <sub>rB</sub> , t <sub>fB</sub> | Input rise<br>time, input<br>fall time | B-port<br>rise and<br>fall times | 0.9 | 3.8             | 0.6 | 3.2             | 0.5 | 2.8             | 0.4 | 2.7           | ns   |
| t <sub>SK(O)</sub>                | Skew<br>(time),<br>output              | Channel-to-<br>channel skew      |     | 0.5             |     | 0.5             |     | 0.5             |     | 0.5           | ns   |
|                                   | Maximum<br>data rate                   |                                  | 60  |                 | 60  |                 | 60  |                 | 60  |               | Mbps |



## 5.18 Switching Characteristics: V<sub>CCA</sub> = 2.5 V $\pm$ 0.2 V (BQA/DYY)

| DAE                               |  | TEST                             | V <sub>CCB</sub> = 2. | $.5 V \pm 0.2 V 	V_{CCB} = 3.3 V \pm 0.3 V 	V_{CCB} = 5 V \pm$ |     |     |     | V ± 0.5 V |      |
|-----------------------------------|--|----------------------------------|-----------------------|--|-----|-----|-----|-----------|------|
| PAR                               | RAMETER                                | CONDITIONS                       | MIN                   | MAX  | MIN | MAX | MIN | MAX       | UNIT |
|                                   | Propagatio                             | A-to-B                           | 1.1                   | 6.3  | 1   | 5.2 | 0.9 | 4.7       |      |
| t <sub>pd</sub>                   | n delay<br>time                        | B-to-A                           | 1.2                   | 6.6  | 1.1 | 5.1 | 0.9 | 4.4       | ns   |
|                                   | Enable                                 | OE-to-A                          |                       | 1  |     | 1   |     | 1         |      |
| t <sub>en</sub>                   | time                                   | OE-to-B                          |                       | 1  |     | 1   |     | 1         | μs   |
| +                                 | Disable<br>time                        | OE-to-A                          | 190                   | 252  | 137 | 184 | 133 | 169       | ns   |
| t <sub>dis</sub>                  |  | OE-to-B                          | 190                   | 252  | 137 | 184 | 133 | 169       |      |
| t <sub>rA</sub> , t <sub>fA</sub> | Input rise<br>time, input<br>fall time | A-port<br>rise and<br>fall times | 0.8                   | 3  | 0.8 | 3   | 0.8 | 3         | ns   |
| t <sub>rB</sub> , t <sub>fB</sub> | Input rise<br>time, input<br>fall time | B-port<br>rise and<br>fall times | 0.7                   | 2.6  | 0.5 | 2.8 | 0.4 | 2.7       | ns   |
| t <sub>SK(O)</sub>                | Skew<br>(time),<br>output              | Channel-to-<br>channel skew      |                       | 0.5  |     | 0.5 |     | 0.5       | ns   |
|                                   | Maximum<br>data rate                   |                                  | 100                   |  | 100 | 1   | 100 |           | Mbps |

over recommended operating free-air temperature range, V<sub>CCA</sub> = 2.5 V ± 0.2 V (unless otherwise noted)

### 5.19 Switching Characteristics: V<sub>CCA</sub> = 2.5 V ± 0.2 V (Other Packages)

over recommended operating free-air temperature range,  $V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V}$  (unless otherwise noted)

| DAD                               | AMETER                                 | TEST                             | V <sub>CCB</sub> = 2. | 5 V ± 0.2 V | V <sub>CCB</sub> = 3. | 3 V ± 0.3 V | V <sub>CCB</sub> = 5 | V ± 0.5 V |      |
|-----------------------------------|--|----------------------------------|-----------------------|-------------|-----------------------|-------------|----------------------|-----------|------|
| PAR                               | AIVIETER                               | CONDITIONS                       | MIN                   | MIN MAX MIN |                       | MAX         | MIN                  | MIN MAX   |      |
|                                   | 1 0                                    | A-to-B                           | 1.1                   | 6.3         | 1                     | 5.2         | 0.9                  | 4.7       |      |
| t <sub>pd</sub>                   | n delay<br>time                        | B-to-A                           | 1.2                   | 6.6         | 1.1                   | 5.1         | 0.9                  | 4.4       | ns   |
| 1                                 | Enable                                 | OE-to-A                          |                       | 1           |                       | 1           |                      | 1         |      |
| t <sub>en</sub>                   | time                                   | OE-to-B                          |                       | 1           |                       | 1           |                      | 1         | – µs |
|                                   | Disable<br>time                        | OE-to-A                          | 5.1                   | 21.3        | 4.6                   | 15.2        | 4.6                  | 13.2      | ns   |
| t <sub>dis</sub>                  |  | OE-to-B                          | 4.4                   | 20.8        | 3.8                   | 16          | 3.9                  | 13.9      |      |
| t <sub>rA</sub> , t <sub>fA</sub> | Input rise<br>time, input<br>fall time | A-port<br>rise and<br>fall times | 0.8                   | 3           | 0.8                   | 3           | 0.8                  | 3         | ns   |
| t <sub>rB</sub> , t <sub>fB</sub> | Input rise<br>time, input<br>fall time | B-port<br>rise and<br>fall times | 0.7                   | 2.6         | 0.5                   | 2.8         | 0.4                  | 2.7       | ns   |
| t <sub>SK(O)</sub>                | Skew<br>(time),<br>output              | Channel-to-<br>channel skew      |                       | 0.5         |                       | 0.5         |                      | 0.5       | ns   |
|                                   | Maximum<br>data rate                   |                                  | 100                   |             | 100                   |             | 100                  |           | Mbps |



## 5.20 Switching Characteristics: $V_{CCA}$ = 3.3 V ± 0.3 V (BQA/DYY)

over recommended operating free-air temperature range,  $V_{CCA} = 3.3 \text{ V} \pm 0.3 \text{ V}$  (unless otherwise noted)

| PARAMETER                         |  | TEST                             | V <sub>CCB</sub> = 3.3 | 3 V ± 0.3 V | V <sub>CCB</sub> = 5 | V <sub>CCB</sub> = 5 V ± 0.5 V |      |  |  |  |
|-----------------------------------|--|----------------------------------|------------------------|-------------|----------------------|--------------------------------|------|--|--|--|
|                                   |  | CONDITIONS                       | MIN                    | MAX         | MIN                  | MAX                            |      |  |  |  |
| +                                 | Propagation                            | A-to-B                           | 0.9                    | 4.7         | 0.8                  | 4                              |      |  |  |  |
| t <sub>pd</sub>                   | delay time                             | B-to-A                           | 1                      | 4.9         | 0.9                  | 3.8                            | ns   |  |  |  |
|                                   | Enchla time                            | OE-to-A                          |                        | 1           |                      | 1                              |      |  |  |  |
| t <sub>en</sub>                   | Enable time                            | OE-to-B                          |                        | 1           |                      | 1                              | — μs |  |  |  |
| +                                 | Disable time                           | OE-to-A                          | 137                    | 183         | 97.6                 | 127                            |      |  |  |  |
| t <sub>dis</sub>                  |  | OE-to-B                          | 137                    | 183         | 97.6                 | 127                            | – ns |  |  |  |
| t <sub>rA</sub> , t <sub>fA</sub> | Input rise<br>time, input<br>fall time | A-port<br>rise and<br>fall times | 0.7                    | 2.5         | 0.7                  | 2.5                            | ns   |  |  |  |
| t <sub>rB</sub> , t <sub>fB</sub> | Input rise<br>time, input<br>fall time | B-port<br>rise and<br>fall times | 0.5                    | 2.1         | 0.4                  | 2.7                            | ns   |  |  |  |
| t <sub>SK(O)</sub>                | Skew (time),<br>output                 | Channel-to-channel<br>skew       |                        | 0.5         |                      | 0.5                            | ns   |  |  |  |
|                                   | Maximum<br>data rate                   |                                  | 100                    |             | 100                  |                                | Mbps |  |  |  |

## 5.21 Switching Characteristics: $V_{CCA}$ = 3.3 V ± 0.3 V (Other Packages)

over recommended operating free-air temperature range, V<sub>CCA</sub> = 3.3 V ± 0.3 V (unless otherwise noted)

| DAI                               | RAMETER                                | TEST                             | V <sub>CCB</sub> = 3.3 | 3 V ± 0.3 V | V <sub>CCB</sub> = 5 | V ± 0.5 V |      |  |
|-----------------------------------|--|----------------------------------|------------------------|-------------|----------------------|-----------|------|--|
| PAI                               | RAIVIEIER                              | CONDITIONS                       | MIN MAX                |             | MIN                  | MAX       |      |  |
| +                                 | Propagation                            | A-to-B                           | 0.9                    | 4.7         | 0.8                  | 4         |      |  |
| t <sub>pd</sub>                   | delay time                             | B-to-A                           | 1                      | 4.9         | 0.9                  | 3.8       | – ns |  |
|                                   | Enchle time                            | OE-to-A                          |                        | 1           |                      | 1         |      |  |
| t <sub>en</sub>                   | Enable time                            | OE-to-B                          |                        | 1           |                      | 1         | – μs |  |
| +                                 | Disable time                           | OE-to-A                          | 4.6                    | 15.2        | 4.3                  | 12.1      |      |  |
| t <sub>dis</sub>                  |  | OE-to-B                          | 3.8                    | 16          | 3.4                  | 13.2      | – ns |  |
| t <sub>rA</sub> , t <sub>fA</sub> | Input rise<br>time, input<br>fall time | A-port<br>rise and<br>fall times | 0.7                    | 2.5         | 0.7                  | 2.5       | ns   |  |
| t <sub>rB</sub> , t <sub>fB</sub> | Input rise<br>time, input<br>fall time | B-port<br>rise and<br>fall times | 0.5                    | 2.1         | 0.4                  | 2.7       | ns   |  |
| t <sub>SK(O)</sub>                | Skew (time),<br>output                 | Channel-to-channel<br>skew       |                        | 0.5         |                      | 0.5       | ns   |  |
|                                   | Maximum<br>data rate                   |                                  | 100                    |             | 100                  |           | Mbps |  |



## 5.22 Operating Characteristics: $V_{CCA}$ = 1.2 V to 1.5 V, $V_{CCB}$ = 1.5 V to 1.8 V

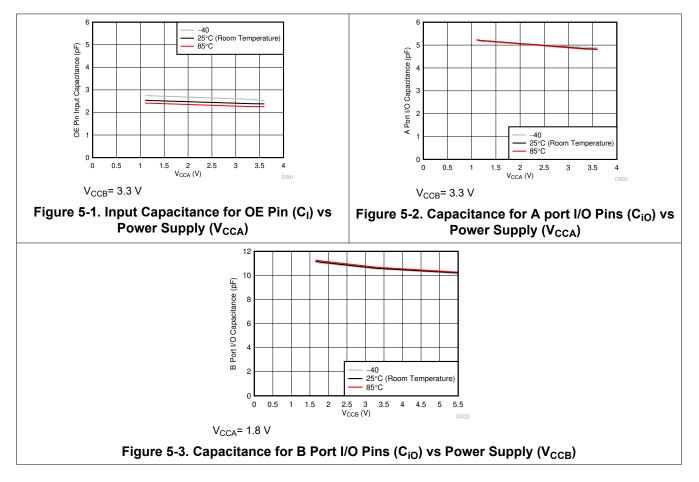
T<sub>A</sub> = 25°C

| DA               | RAMETER                             | TEST CONDITIONS  |                                | V <sub>CCA</sub> = 1.2 | V, V <sub>CCB</sub> = | 1.5 V | V <sub>CCA</sub> = 1.2 | 2 V, V <sub>ССВ</sub> : | = 1.8 V | V <sub>CCA</sub> = 1.5 | V, V <sub>ССВ</sub> : | = 1.8 V | UNIT |
|------------------|-------------------------------------|--|--------------------------------|------------------------|-----------------------|-------|------------------------|-------------------------|---------|------------------------|-----------------------|---------|------|
| FA               | RAIVIETER                           | TEST CO  | MIN                            | TYP                    | MAX                   | MIN   | TYP                    | MAX                     | MIN     | TYP                    | MAX                   | UNIT    |      |
| 6                | Power<br>dissipation                | 0 - 0  | A-port input,<br>B-port output |                        | 7.8                   |       |                        | 10                      |         |                        | 9                     |         |      |
| C <sub>pdA</sub> | capacitance                         | C <sub>L</sub> = 0<br>f = 10 MHz<br>t <sub>r</sub> = t <sub>f</sub> = 1 ns | B-port input,<br>A-port output |                        | 12                    |       |                        | 11                      |         |                        | 11                    |         | ~F   |
| Power            | OE = V <sub>CCA</sub><br>(outputs   | A-port input,<br>B-port output   |                                | 38.1                   |                       |       | 28                     |                         |         | 28                     |                       | pF      |      |
| C <sub>pdB</sub> | dissipation<br>capacitance          | enabled)   | B-port input,<br>A-port output |                        | 25.4                  |       |                        | 19                      |         |                        | 18                    |         |      |
| 6                | Power<br>dissipation                | C <sub>1</sub> = 0   | A-port input,<br>B-port output |                        | 0.01                  |       |                        | 0.01                    |         |                        | 0.01                  |         |      |
| C <sub>pdA</sub> | capacitance                         | f = 10 MHz<br>t <sub>r</sub> = t <sub>f</sub> = 1 ns                       | B-port input,<br>A-port output |                        | 0.01                  |       |                        | 0.01                    |         |                        | 0.01                  |         | pF   |
|                  | Power<br>dissipation<br>capacitance | OE = GND<br>(outputs<br>disabled)  | A-port input,<br>B-port output |                        | 0.01                  |       |                        | 0.01                    |         |                        | 0.01                  |         | pi   |
| C <sub>pdB</sub> |                                     | disabled)  | B-port input,<br>A-port output |                        | 0.01                  |       |                        | 0.01                    |         |                        | 0.01                  |         |      |

## 5.23 Operating Characteristics: $V_{CCA}$ = 1.8 V to 3.3 V, $V_{CCB}$ = 1.8 V to 5 V

| T <sub>A</sub> = | 25°C                                |   |                                |   |      |     |  |      |     |   |      |     |  |      |  |    |
|------------------|-------------------------------------|---|--------------------------------|---|------|-----|--|------|-----|---|------|-----|--|------|--|----|
| PA               | RAMETER                             | TEST CC                                       |                                | <sub>са</sub> = 1.8<br><sub>св</sub> =1.8 |      |     | <sub>са</sub> = 2.5<br><sub>св</sub> = 2.5 |      |     | <sub>са</sub> = 2.5<br><sub>ссв</sub> = 5 |      |     | V <sub>CCA</sub> = 3.3 V,<br>V <sub>CCB</sub> = 3.3 V to 5 V |      |  |    |
|                  |                                     |   | MIN                            | TYP                                       | MAX  | MIN | TYP  | MAX  | MIN | TYP                                       | MAX  | MIN | TYP  | MAX  |  |    |
| 6                | Power<br>dissipation                | C <sub>1</sub> = 0                            | A-port input,<br>B-port output |   | 8    |     |  | 8    |     |   | 8    |     |  | 9    |  |    |
| C <sub>pdA</sub> | capacitance                         |   | B-port input,<br>A-port output |   | 11   |     |  | 11   |     |   | 11   |     |  | 11   |  | pF |
| 6                | Power                               | OE = V <sub>CCA</sub><br>(outputs<br>enabled) | A-port input,<br>B-port output |   | 28   |     |  | 29   |     |   | 29   |     |  | 29   |  | рг |
| C <sub>pdB</sub> |                                     |   | B-port input,<br>A-port output |   | 18   |     |  | 19   |     |   | 21   |     |  | 22   |  |    |
| 6                |                                     | on $C_1 = 0$                                  | A-port input,<br>B-port output |   | 0.01 |     |  | 0.01 |     |   | 0.01 |     |  | 0.01 |  |    |
| C <sub>pdA</sub> |                                     |   | B-port input,<br>A-port output |   | 0.01 |     |  | 0.01 |     |   | 0.01 |     |  | 0.01 |  | pF |
| 6                | Power<br>dissipation<br>capacitance | OE = GND<br>(outputs<br>disabled)             | A-port input,<br>B-port output |   | 0.01 |     |  | 0.01 |     |   | 0.01 |     |  | 0.03 |  | Ы  |
| C <sub>pdB</sub> |                                     |   | B-port input,<br>A-port output |   | 0.01 |     |  | 0.01 |     |   | 0.01 |     |  | 0.04 |  |    |

## 5.24 Typical Characteristics





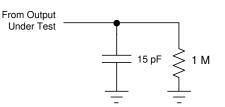
### **6** Parameter Measurement Information

Unless otherwise noted, all input pulses are supplied by generators that have the following characteristics:

- PRR 10 MHz
- Z<sub>O</sub> = 50 W
- dv/dt ≥ 1 V/ns

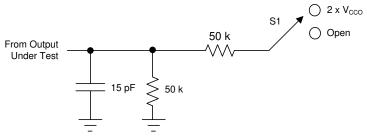
#### Note

All parameters and waveforms are not applicable to all devices.



A. The outputs are measured one at a time, with one transition per measurement.

#### Figure 6-1. Load Circuit For Maximum Data Rate: Pulse Duration, Propagation Delay Output Rise, And Fall Time Measurement



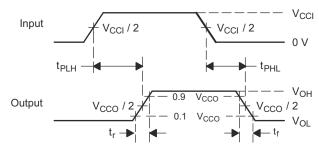
A. The outputs are measured one at a time, with one transition per measurement.

### Figure 6-2. Load Circuit For Enable and Disable Time Measurement

#### Table 6-1. Switch Position For Enable and Disable Time Measurement (See Figure 6-2)

| TEST                                | S1                 |
|-------------------------------------|--------------------|
| t <sub>PZL</sub> , t <sub>PLZ</sub> | $2 \times V_{CCO}$ |
| t <sub>PHZ</sub> , t <sub>PZH</sub> | Open               |





- A.  $V_{CCI}$  is the  $V_{CC}$  associated with the input port.
- B.  $V_{CCO}$  is the  $_{VCC}$  associated with the output port.
- $\label{eq:C.total} \text{C}. \quad t_{\text{PLH}} \text{ and } t_{\text{PHL}} \text{ are the same as } t_{\text{pd}}.$
- D. The outputs are measured one at a time, with one transition per measurement.

#### Figure 6-3. Voltage Waveforms Propagation Delay Times

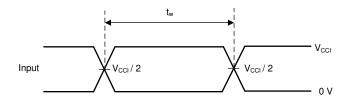


Figure 6-4. Voltage Waveforms Pulse Duration

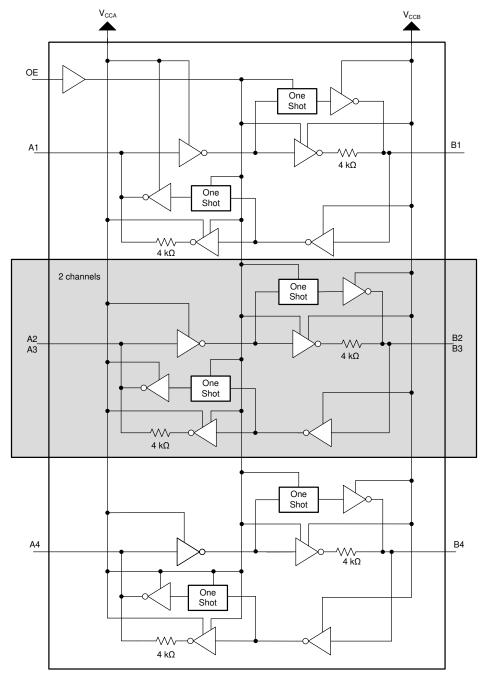


## 7 Detailed Description

### 7.1 Overview

The TXB0104 device is a 4-bit, directionless voltage-level translator specifically designed for translating logic voltage levels. The A port is able to accept I/O voltages ranging from 1.2 V to 3.6 V, while the B port can accept I/O voltages from 1.65 V to 5.5 V. The device is a buffered architecture with edge-rate accelerators (one-shots) to improve the overall data rate. This device can only translate push-pull CMOS logic outputs. If for open-drain signal translation, please refer to TI's TXS010X products.

### 7.2 Functional Block Diagram





#### 7.3 Feature Description

#### 7.3.1 Architecture

The TXB0104 device architecture (see Figure 7-1) does not require a direction-control signal to control the direction of data flow from A to B or from B to A. In a DC state, the output drivers of the device maintain a high or low, but are designed to be weak, so the output drivers can be overdriven by an external driver when data on the bus flows the opposite direction.

The output one-shots detect rising or falling edges on the A or B ports. During a rising edge, the one-shot turns on the PMOS transistors (T1, T3) for a short duration, which speeds up the low-to-high transition. Similarly, during a falling edge, the one-shot turns on the NMOS transistors (T2, T4) for a short duration, which speeds up the high-to-low transition. The typical output impedance during output transition is 70  $\Omega$  at V<sub>CCO</sub> = 1.2 V to 1.8 V, 50  $\Omega$  at V<sub>CCO</sub> = 1.8 V to 3.3 V, and 40  $\Omega$  at V<sub>CCO</sub> = 3.3 V to 5 V.

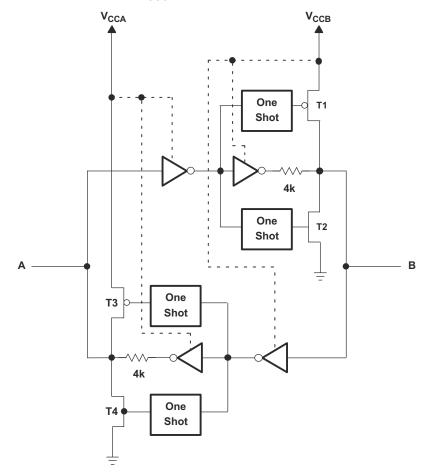
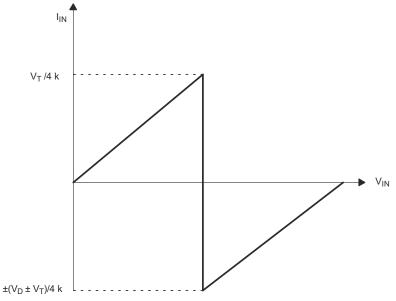


Figure 7-1. Architecture of TXB0104 Device I/O Cell



#### 7.3.2 Input Driver Requirements

Typical  $I_{IN}$  vs  $V_{IN}$  characteristics of the device are shown in Figure 7-2. For proper operation, the device driving the data I/Os of the TXB0104 device must have drive strength of at least ±2 mA.



- A.  $V_T$  is the input threshold of the TXB0104 device, (typically  $V_{CC}$  / 2).
- B.  $V_D$  is the supply voltage of the external driver.

#### Figure 7-2. Typical IIN vs VIN Curve

#### 7.3.3 Output Load Considerations

TI recommends careful PCB layout practices with short PCB trace lengths to avoid excessive capacitive loading and to ensure that proper O.S. triggering takes place. PCB signal trace-lengths must be kept short enough such that the round trip delay of any reflection is less than the one-shot duration. This improves signal integrity by ensuring that any reflection sees a low impedance at the driver. The O.S. circuits have been designed to stay on for approximately 10 ns. The maximum capacitance of the lumped load that can be driven also depends directly on the one-shot duration. With very heavy capacitive loads, the one-shot can time-out before the signal is driven fully to the positive rail. The O.S. duration has been set to best optimize trade-offs between dynamic ICC, load driving capability, and maximum bit-rate considerations. Both PCB trace length and connectors add to the capacitance that the device output sees, so it is recommended that this lumped-load capacitance be considered to avoid O.S. retriggering, bus contention, output signal oscillations, or other adverse system-level affects.



#### 7.3.4 Enable and Disable

The TXB0104 device has an OE input that is used to disable the device by setting OE = low, which places all I/Os in the high-impedance (Hi-Z) state. The disable time  $(t_{dis})$  indicates the delay between when OE goes low and when the outputs acutally get disabled (Hi-Z). The enable time  $(t_{en})$  indicates the amount of time the user must allow for the one-shot circuitry to become operational after OE is taken high.

#### 7.3.5 Pullup or Pulldown Resistors on I/O Lines

The device is designed to drive capacitive loads of up to 70 pF. The output drivers of the TXB0104 device have low dc drive strength. If pullup or pulldown resistors are connected externally to the data I/Os, their values must be kept higher than 50 k $\Omega$  to ensure that they do not contend with the output drivers of the TXB0104 device.

For the same reason, the TXB0104 device must not be used in applications such as I<sup>2</sup>C or 1-Wire where an open-drain driver is connected on the bidirectional data I/O. For these applications, use a device from the TI TXS01xx series of level translators.

#### 7.4 Device Functional Modes

The device has two functional modes, enabled and disabled. To disable the device, set the OE input to low, which places all I/Os in a high impedance state. Setting the OE input to high will enable the device.



## 8 Application and Implementation

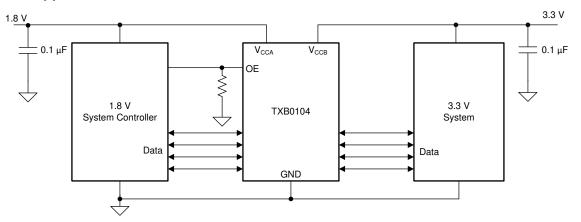
#### Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

#### 8.1 Application Information

The TXB0104 device can be used in level-translation applications for interfacing devices or systems operating at different interface voltages with one another. It can only translate push-pull CMOS logic outputs. If for open-drain signal translation, please refer to TI TXS010X products. Any external pulldown or pullup resistors are recommended larger than 50 k $\Omega$ .

#### 8.2 Typical Application



#### 8.2.1 Design Requirements

For this design example, use the parameters listed in Table 8-1. And make sure the  $V_{CCA} \leq V_{CCB}$ .

#### Table 8-1. Design Parameters

| DESIGN PARAMETERS    | EXAMPLE VALUE   |
|----------------------|-----------------|
| Input voltage range  | 1.2 V to 3.6 V  |
| Output voltage range | 1.65 V to 5.5 V |



#### 8.2.2 Detailed Design Procedure

To begin the design process, determine the following:

Input voltage range

- Use the supply voltage of the device that is driving the TXB0104 device to determine the input voltage range. For a valid logic high, the value must exceed the  $V_{IH}$  of the input port. For a valid logic low, the value must be less than the  $V_{IL}$  of the input port.

- Output voltage range
- Use the supply voltage of the device that the device is driving to determine the output voltage range.

- External pullup or pulldown resistors are not recommended. If mandatory, it is recommended that the value must be larger than 50 k $\Omega$ .

• An external pulldown or pullup resistor decreases the output V<sub>OH</sub> and V<sub>OL</sub>. Use the below equations to draft estimate the V<sub>OH</sub> and V<sub>OL</sub> as a result of an external pulldown and pullup resistor.

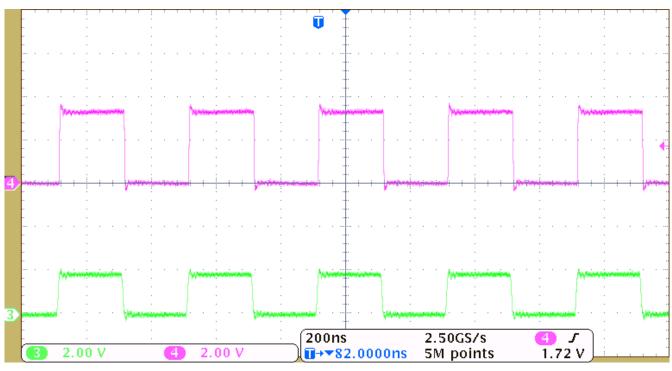
 $V_{OH} = V_{CCx} \times R_{PD} / (R_{PD} + 4.5 \text{ k}\Omega)$ 

 $V_{OL} = V_{CCx} \times 4.5 \text{ k}\Omega / (R_{PU} + 4.5 \text{ k}\Omega)$ 

Where

- $V_{CCx}$  is the output port supply voltage on either  $V_{CCA}$  or  $V_{CCB}$
- R<sub>PD</sub> is the value of the external pull down resistor
- R<sub>PU</sub> is the value of the external pull up resistor
- 4.5 k $\Omega$  is the counting the variation of the serial resistor 4 k $\Omega$  in the I/O line.

#### 8.2.3 Application Curves



#### Figure 8-1. Level-Translation of a 2.5-MHz Signal



## 9 Power Supply Recommendations

During operation, ensure that  $V_{CCA} \le V_{CCB}$  at all times. During power-up sequencing,  $V_{CCA} \ge V_{CCB}$  does not damage the device, so any power supply can be ramped up first. The device has circuitry that disables all output ports when either  $V_{CC}$  is switched off ( $V_{CCA/B} = 0$  V). The output-enable (OE) input circuit is designed so that it is supplied by  $V_{CCA}$  and when the (OE) input is low, all outputs are placed in the high-impedance state. To ensure the high-impedance state of the outputs during power up or power down, the OE input pin must be tied to GND through a pulldown resistor and must not be enabled until  $V_{CCA}$  and  $V_{CCB}$  are fully ramped and stable. The minimum value of the pulldown resistor to ground is determined by the current-sourcing capability of the driver.

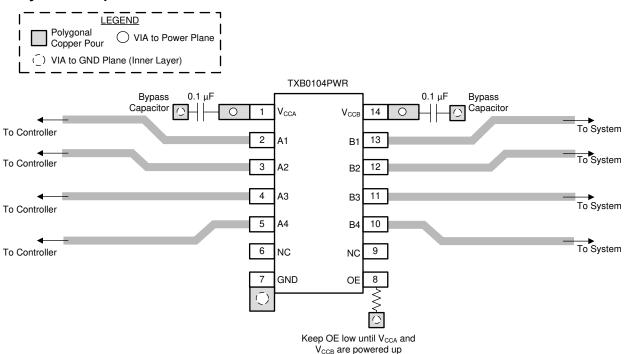
## 10 Layout

### **10.1 Layout Guidelines**

To ensure reliability of the device, following common printed-circuit board layout guidelines is recommended.

- Bypass capacitors must be used on power supplies, and must be placed as close as possible to the  $V_{CCA}$ ,  $V_{CCB}$  pin and GND pin.
- Short trace-lengths must be used to avoid excessive loading.
- PCB signal trace-lengths must be kept short enough so that the round-trip delay of any reflection is less than the one-shot duration, approximately 10 ns, ensuring that any reflection encounters low impedance at the source driver.

### 10.2 Layout Example





## **11 Device and Documentation Support**

### **11.1 Receiving Notification of Documentation Updates**

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on *Notifications* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

#### **11.2 Support Resources**

TI E2E<sup>™</sup> support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

#### 11.3 Trademarks

BGA MICROSTAR JUNIOR<sup>™</sup> is a trademark of Texas Instruments. TI E2E<sup>™</sup> is a trademark of Texas Instruments. All trademarks are the property of their respective owners.

#### **11.4 Electrostatic Discharge Caution**



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

#### 11.5 Glossary

TI Glossary This glossary lists and explains terms, acronyms, and definitions.



## **12 Revision History**

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| С | hanges from Revision J (October 2020) to Revision K (March 2025) | Page |
|---|--|------|
| • | Added BQA and DYY packages                                       | 1    |
| • | Added thermal information for BQA and DYY packages               | 6    |

| Changes from Revision I (March 2018) to Revision J (October 2020) |  |   |  |  |  |  |
|---|--|---|--|--|--|--|
| •   | Updated the numbering format for tables, figures, and cross-references throughout the document | 1 |  |  |  |  |
| •   | Added NMN Package, 12-Pin NFBGA pinout drawing in Pin Configuration and Functions section      | 3 |  |  |  |  |

| С | hanges from Revision H (January 2018) to Revision I (March 2018) | Page |
|---|--|------|
| • | Updated Pin Functions table                                      |      |
|   | Added Pin Assignments table for YZT package                      |      |
|   | Added Pin Assignments table for GXU and ZXU package              |      |
|   | Updated Layout Example   |      |

| C | hanges from Revision G (November 2014) to Revision H (January 2018)                            | Page |
|---|--|------|
| • | Added Package, families to Package, pinout drawings in Pin Configuration and Functions section | 3    |
| • | Added junction temperature range in Absolute Maximum Ratingstable                              | 5    |
| • | Changed unit from V to kV in ESD Ratings table   | 5    |

#### Changes from Revision F (May 2012) to Revision G (November 2014)

Page

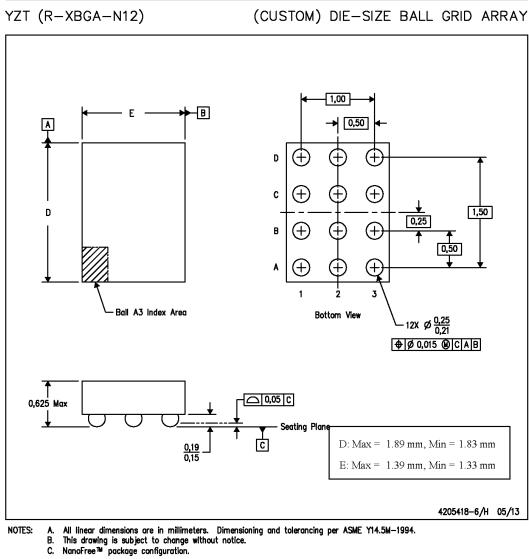
 Added Pin Configuration and Functions section, Handling Rating table, Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section

### 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



#### **MECHANICAL DATA**



C.

NanoFree is a trademark of Texas Instruments.

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## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material | MSL Peak Temp       | Op Temp (°C) | Device Marking<br>(4/5) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|-------------------------------|---------------------|--------------|-------------------------|---------|
|                  |               |              |                    |      |                |                 | (6)                           |                     |              |                         |         |
| TXB0104BQAR      | ACTIVE        | WQFN         | BQA                | 14   | 3000           | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM  | -40 to 85    | YE04                    | Samples |
| TXB0104D         | ACTIVE        | SOIC         | D                  | 14   | 50             | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM  | -40 to 85    | TXB0104                 | Samples |
| TXB0104DG4       | ACTIVE        | SOIC         | D                  | 14   | 50             | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM  | -40 to 85    | TXB0104                 | Samples |
| TXB0104DR        | ACTIVE        | SOIC         | D                  | 14   | 2500           | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM  | -40 to 85    | TXB0104                 | Samples |
| TXB0104DRG4      | ACTIVE        | SOIC         | D                  | 14   | 2500           | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM  | -40 to 85    | TXB0104                 | Samples |
| TXB0104NMNR      | ACTIVE        | NFBGA        | NMN                | 12   | 2500           | RoHS & Green    | SNAGCU                        | Level-2-260C-1 YEAR | -40 to 85    | 2AQW                    | Samples |
| TXB0104PWR       | ACTIVE        | TSSOP        | PW                 | 14   | 2000           | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM  | -40 to 85    | YE04                    | Samples |
| TXB0104PWRG4     | ACTIVE        | TSSOP        | PW                 | 14   | 2000           | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM  | -40 to 85    | YE04                    | Samples |
| TXB0104RGYR      | ACTIVE        | VQFN         | RGY                | 14   | 3000           | RoHS & Green    | NIPDAU                        | Level-2-260C-1 YEAR | -40 to 85    | YE04                    | Samples |
| TXB0104RGYRG4    | ACTIVE        | VQFN         | RGY                | 14   | 3000           | RoHS & Green    | NIPDAU                        | Level-2-260C-1 YEAR | -40 to 85    | YE04                    | Samples |
| TXB0104RUTR      | ACTIVE        | UQFN         | RUT                | 12   | 3000           | RoHS & Green    | NIPDAUAG                      | Level-1-260C-UNLIM  | -40 to 85    | (2KR, 2KV)              | Samples |
| TXB0104YZTR      | ACTIVE        | DSBGA        | YZT                | 12   | 3000           | RoHS & Green    | SNAGCU                        | Level-1-260C-UNLIM  | -40 to 85    | 2К                      | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <= 1000ppm threshold. Antimony trioxide based flame retardants must also meet the <= 1000ppm threshold requirement.



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## PACKAGE OPTION ADDENDUM

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF TXB0104 :

• Automotive : TXB0104-Q1

NOTE: Qualified Version Definitions:

• Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects



Texas

STRUMENTS

### TAPE AND REEL INFORMATION





#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| *All dimensions are nominal |                 |                    |    |      |                          |                          |            |            |            |            |           |                  |
|-----------------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device                      | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
| TXB0104BQAR                 | WQFN            | BQA                | 14 | 3000 | 180.0                    | 12.4                     | 2.8        | 3.3        | 1.1        | 4.0        | 12.0      | Q1               |
| TXB0104DR                   | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| TXB0104NMNR                 | NFBGA           | NMN                | 12 | 2500 | 180.0                    | 8.4                      | 2.3        | 2.8        | 1.15       | 4.0        | 8.0       | Q2               |
| TXB0104PWR                  | TSSOP           | PW                 | 14 | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| TXB0104RGYR                 | VQFN            | RGY                | 14 | 3000 | 330.0                    | 12.4                     | 3.75       | 3.75       | 1.15       | 8.0        | 12.0      | Q1               |
| TXB0104RUTR                 | UQFN            | RUT                | 12 | 3000 | 180.0                    | 9.5                      | 1.9        | 2.2        | 0.7        | 4.0        | 8.0       | Q1               |
| TXB0104YZTR                 | DSBGA           | YZT                | 12 | 3000 | 180.0                    | 8.4                      | 1.49       | 1.99       | 0.75       | 4.0        | 8.0       | Q2               |



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## PACKAGE MATERIALS INFORMATION

13-Mar-2025



| Device      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TXB0104BQAR | WQFN         | BQA             | 14   | 3000 | 210.0       | 185.0      | 35.0        |
| TXB0104DR   | SOIC         | D               | 14   | 2500 | 356.0       | 356.0      | 35.0        |
| TXB0104NMNR | NFBGA        | NMN             | 12   | 2500 | 210.0       | 185.0      | 35.0        |
| TXB0104PWR  | TSSOP        | PW              | 14   | 2000 | 356.0       | 356.0      | 35.0        |
| TXB0104RGYR | VQFN         | RGY             | 14   | 3000 | 356.0       | 356.0      | 35.0        |
| TXB0104RUTR | UQFN         | RUT             | 12   | 3000 | 189.0       | 185.0      | 36.0        |
| TXB0104YZTR | DSBGA        | YZT             | 12   | 3000 | 182.0       | 182.0      | 20.0        |

## TEXAS INSTRUMENTS

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13-Mar-2025

## TUBE



## - B - Alignment groove width

\*All dimensions are nominal

| Device     | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | Τ (μm) | B (mm) |
|------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| TXB0104D   | D            | SOIC         | 14   | 50  | 506.6  | 8      | 3940   | 4.32   |
| TXB0104DG4 | D            | SOIC         | 14   | 50  | 506.6  | 8      | 3940   | 4.32   |

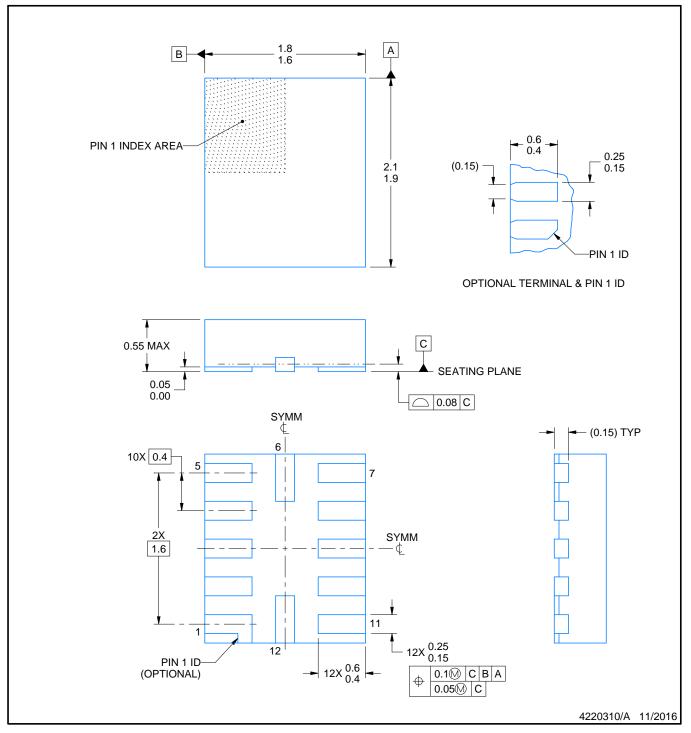
# **RUT0012A**



## **PACKAGE OUTLINE**

## UQFN - 0.55 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES:

- All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
   This drawing is subject to change without notice.

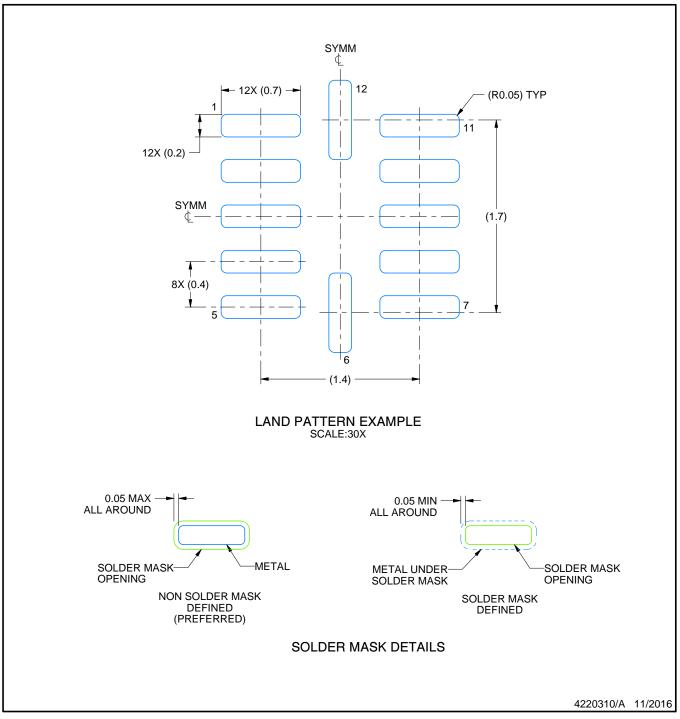


# **RUT0012A**

# **EXAMPLE BOARD LAYOUT**

## UQFN - 0.55 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

3. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).

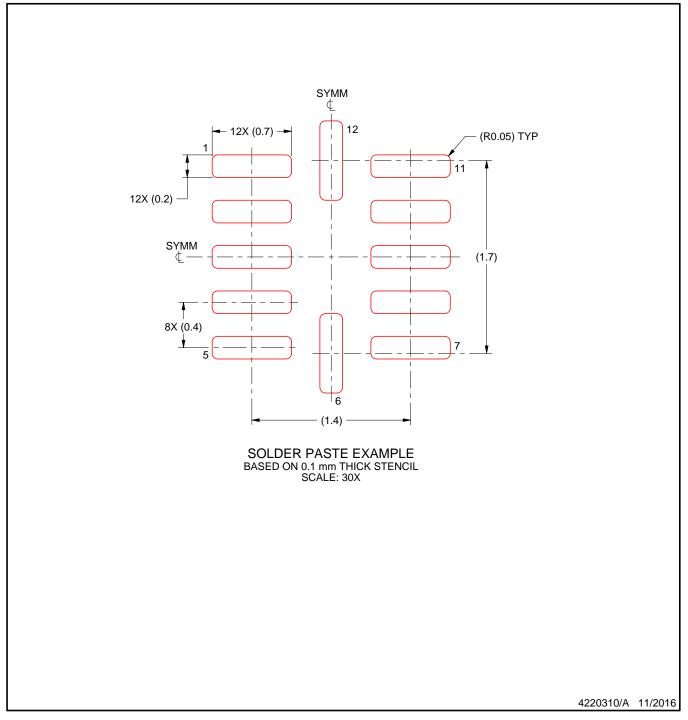


## **RUT0012A**

# **EXAMPLE STENCIL DESIGN**

## UQFN - 0.55 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

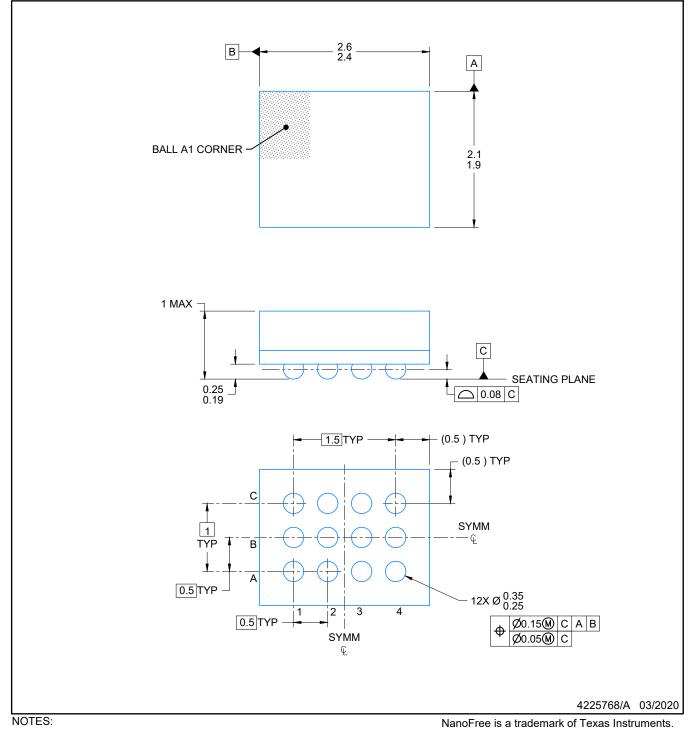


## NMN0012A

# PACKAGE OUTLINE

### NFBGA - 1 mm max height

PLASTIC BALL GRID ARRAY



- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.

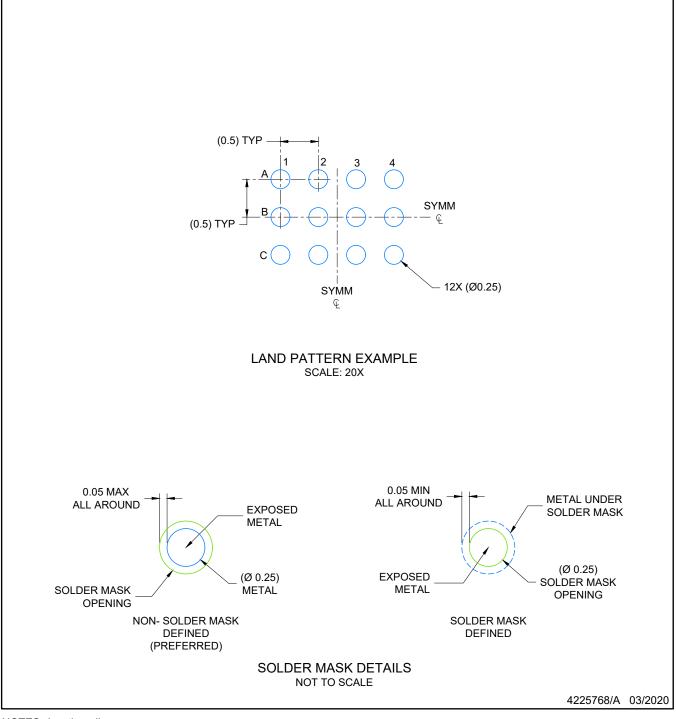


### NMN0012A

### **EXAMPLE BOARD LAYOUT**

#### NFBGA - 1 mm max height

PLASTIC BALL GRID ARRAY



NOTES: (continued)

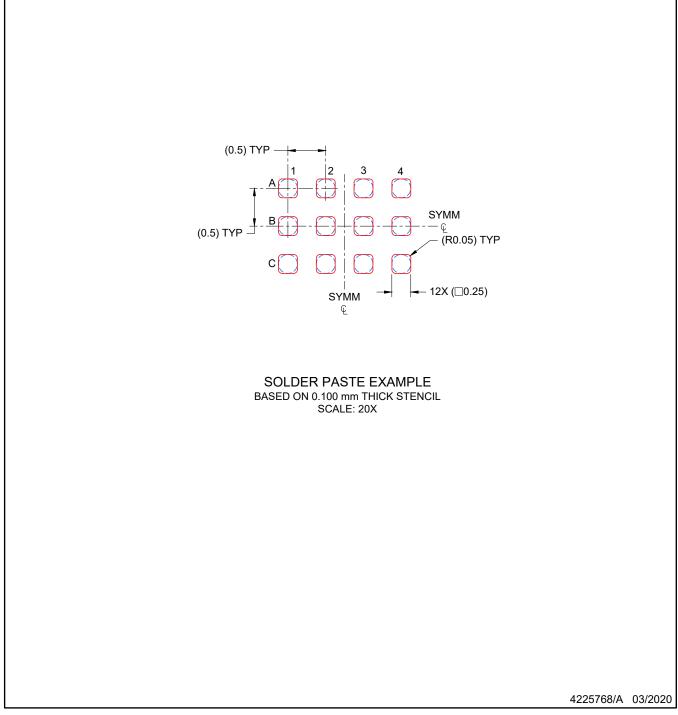
3. Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. Refer to Texas Instruments Literature number SNVA009 (www.ti.com/lit/snva009).



### **EXAMPLE STENCIL DESIGN**

### NFBGA - 1 mm max height

PLASTIC BALL GRID ARRAY



NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.



## **PW0014A**



## **PACKAGE OUTLINE**

#### TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153.



### PW0014A

## **EXAMPLE BOARD LAYOUT**

#### TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



### PW0014A

## **EXAMPLE STENCIL DESIGN**

#### TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

9. Board assembly site may have different recommendations for stencil design.



### **RGY 14**

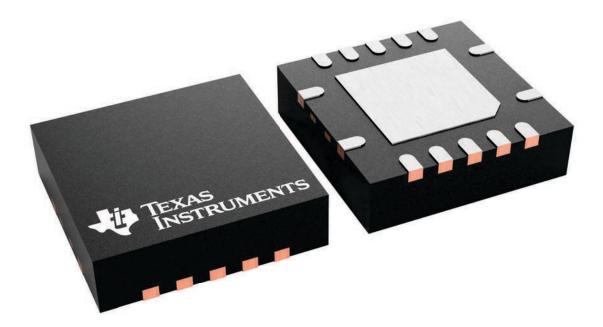
#### 3.5 x 3.5, 0.5 mm pitch

## **GENERIC PACKAGE VIEW**

#### VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.





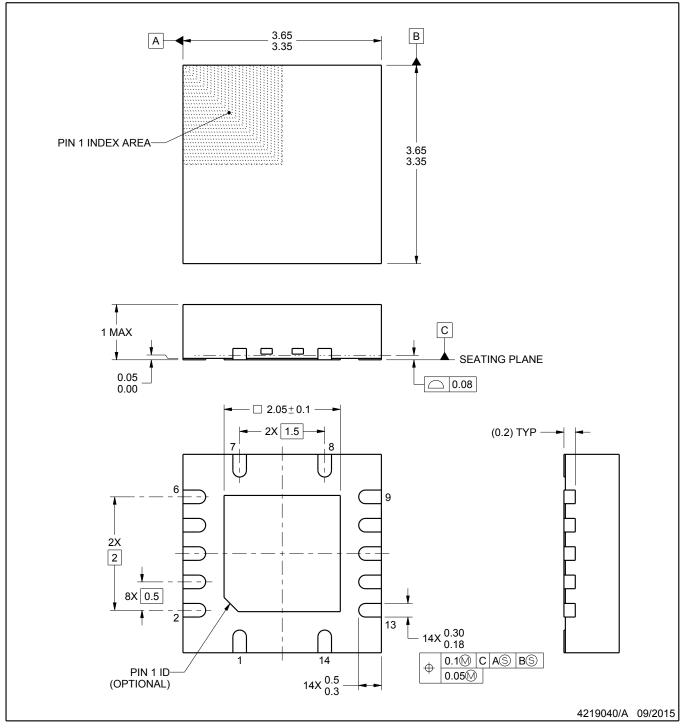
## **RGY0014A**



## **PACKAGE OUTLINE**

#### VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- This drawing is subject to change without notice.
   The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

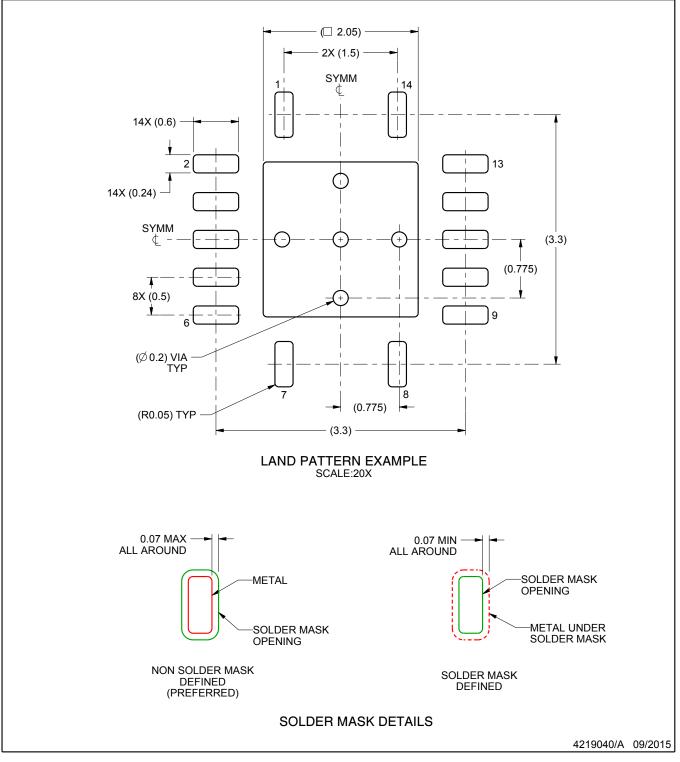


## **RGY0014A**

## **EXAMPLE BOARD LAYOUT**

#### VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).

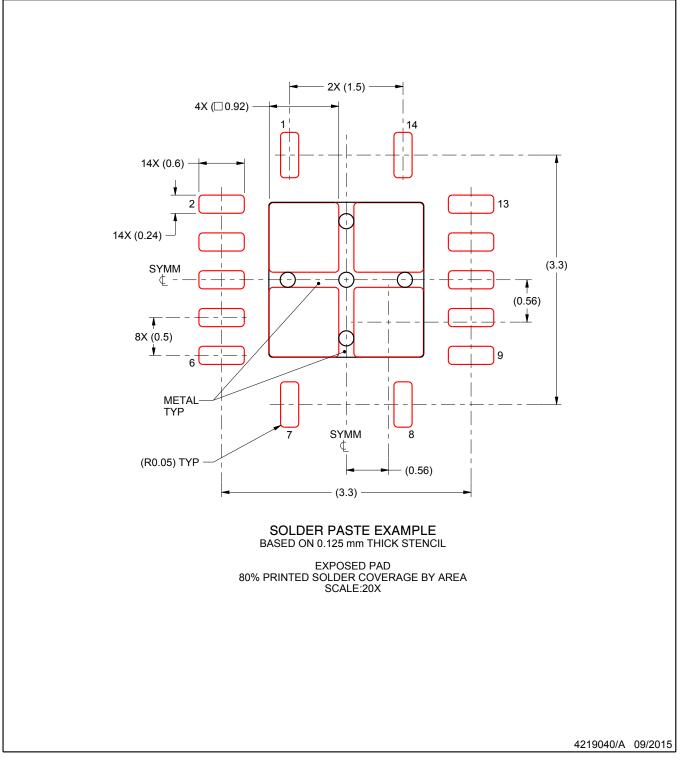


## **RGY0014A**

## **EXAMPLE STENCIL DESIGN**

#### VQFN - 1 mm max height

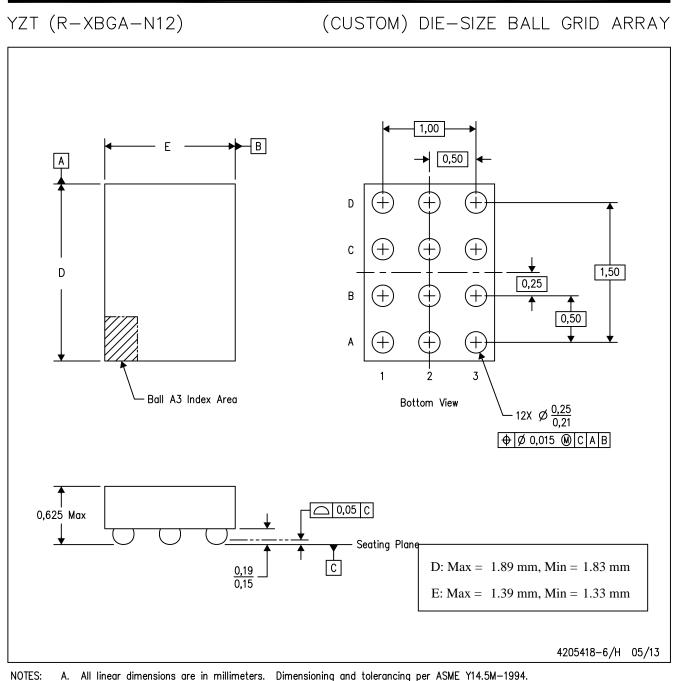
PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

5. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.





B. This drawing is subject to change without notice.

C. NanoFree™ package configuration.

NanoFree is a trademark of Texas Instruments.



## **D0014A**



## **PACKAGE OUTLINE**

#### SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm, per side.
- 5. Reference JEDEC registration MS-012, variation AB.



## D0014A

## **EXAMPLE BOARD LAYOUT**

#### SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



## D0014A

## **EXAMPLE STENCIL DESIGN**

#### SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



### **BQA 14**

2.5 x 3, 0.5 mm pitch

## **GENERIC PACKAGE VIEW**

#### WQFN - 0.8 mm max height

PLASTIC QUAD FLATPACK - NO LEAD

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.





### **BQA0014A**

### **PACKAGE OUTLINE**

#### WQFN - 0.8 mm max height

PLASTIC QUAD FLAT PACK-NO LEAD



- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. The package thermal pad must be soldered to the printed circuit board for optimal thermal and mechanical performance.



### **BQA0014A**

### **EXAMPLE BOARD LAYOUT**

#### WQFN - 0.8 mm max height

PLASTIC QUAD FLAT PACK-NO LEAD



NOTES: (continued)

- 4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
- 5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.



### **BQA0014A**

### **EXAMPLE STENCIL DESIGN**

#### WQFN - 0.8 mm max height

PLASTIC QUAD FLAT PACK-NO LEAD



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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